

PACKAGES LINE-UP FOR RF AND MICROWAVE DEVICES

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Common Information

The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

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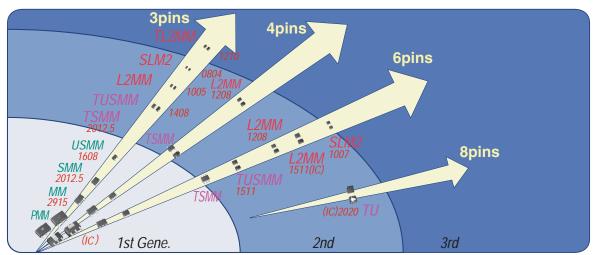
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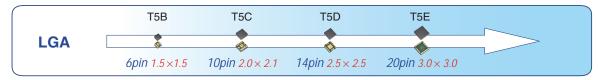
Surface Mount Type Package Line-up Actual Size Illustrations

(Unit: mm, Size not exact)

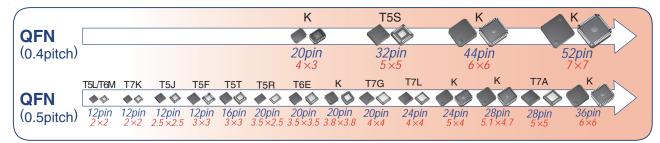
(1) Minimold



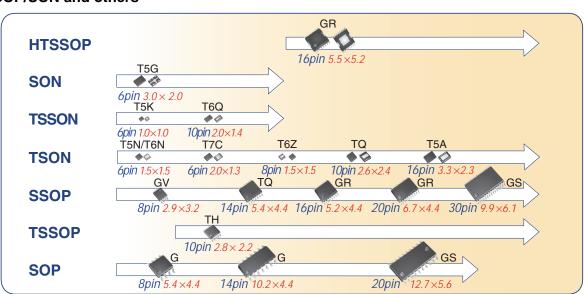
(2) LGA



(3) QFN



(4) SOP/SON and others



List of Surface Mount Type Package Drawings (1/2)

(Magnification of Dimensions \times 2.5)

Abbreviation	ЗММ	3SMM	3USMM	F3TUSMM	3TL2MM	3L2MM
Outline						
Cliagram and	a 🗆	_				
Outline	▎▗▍▐] þ	₽-	Ð	D	Ð
Dimensions		_	~	~_	_	_
L×W×H	J_L	 (A	—	(40 40 00)	
(mm)	(2.9×1.5×1.1)	(2.0×1.3×0.9)	,	$(1.4 \times 0.8 \times 0.6)$	(1.2×1.0×0.3)	(1.0×0.7×0.5)
Abbreviation	3SLM2	3PMM (34 PKG)	4MM	4SMM	F4TSMM	4L2MM
Outline		(Bottom View)				
Cliagram and		፲~\	47-			
Outline Dimensions	D	<u> </u>	<u>d</u> b] [Π	П
L×W×H			_			_
(mm)	(0.0, 0.4, 0.4)	(45 05 45)	,	,	(0.0 4.0 0.0)	
` '	$(0.8 \times 0.4 \times 0.4)$	(4.5×2.5×1.5)		·	(2.0 × 1.3 × 0.6)	$(1.2 \times 0.8 \times 0.5)$
Abbreviation	4PMM	6ММ	6SMM	6TSMM	6L2MM (1511)	F6TUSMM
Outline	(Bottom View)					
Cliagram and Outline	🗄 🖒					
Dimensions	ᅵ겁뚝		1		п	n
L×W×H		<u> </u>	4			9_6
(mm)		, /	/	.		
, ,	,	$(2.9 \times 1.5 \times 1.1)$ (2	, ,	,	, ,	$(1.5\times1.1\times0.6)$
Abbreviation	6L2MM (1208)	6SLM2	6LGA	6SON	6RTSON	6TSON
Outline						
Cliagram and			(Bottom View)	(Bottom View)	(Bottom View)	(Bottom View)
Outline	0	8		- V -		
Dimensions	_					
L × W × H (mm)	$(1.2 \times 0.8 \times 0.5)$	 (1.0 × 0.7 × 0.4)	(15×15×06)	(30~30~08)	(2.0 × 1.3 × 0.4)	$(1.5 \times 1.5 \times 0.4)$
Abbreviation	6TSSON	8SOP	8SS	•	8L2MM	8TSON
Outline	0100011		000	<u> </u>	OLZIVIIVI	010014
Cliagram and			a		ottom View)	
Outline	(Bottom View)	1 120 1 120	0			(Bottom View)
Dimensions	₩.	<u>adb</u>		80 80		
L × W × H	_	<i>_</i>	<i>J</i> =	⇒ .	\Box	
(mm)	$(1.0 \times 1.0 \times 0.4)$	$(5.2 \times 4.4 \times 1.6)$	s) (2.9×3.2	2×1.6) (2.0	$\times \overline{2.0} \times 0.5$) ($1.5 \times 1.5 \times 0.4$)

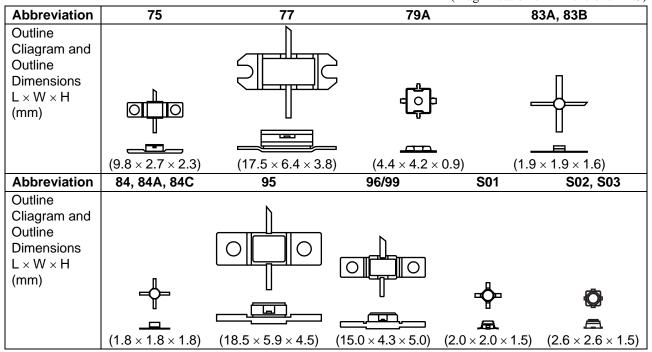
List of Surface Mount Type Package Drawings (2/2)

(Magnification of Dimensions \times 2.5)

	Abbreviation	10TSSOP	10TSON	10TSSON	12QFN	12QFN(T7K) 12TQFN
<r></r>	Outline Cliagram and Outline		(E	Sottom View)	(Bottom View)	(Bottom View)) (Bottom View)
	Dimensions L × W × H (mm)	(2.8×2.2×1.1) (2	.6×2.4×0.6) (2	0×1.4×0.4)	(3.0×3.0×0.8)) (2.0×2.0×0.6	(2.5×2.5×0.4)
	Abbreviation	12TSQFN	14SOP		SOP	14LGA	16HTSSOP
	Outline Cliagram and Outline Dimensions L × W × H (mm)	(Bottom View)			HHHH (I	Bottom View)	(Bottom View)
	(11111)	(2.0×2.0×0.4)	$(10.2 \times 4.4 \times 1.4)$			2.5 × 2.5 × 0.6)	$(5.5 \times 5.2 \times 0.9)$
	Abbreviation	16QFN	16SSOP	16TSO	, ,	20SOP	20SSOP
	Outline Cliagram and Outline Dimensions L × W × H (mm)	(Bottom View)		(Bottom V	iew)		
	, ,	$(3.0 \times 3.0 \times 0.8)$	$(5.2 \times 4.4 \times 1.6)$	(3.3×2.3×		× 5.6 × 1.7)	$(6.7 \times 4.4 \times 1.6)$
	Abbreviation	20QFN (0.4)	20QFN (0.5)(K	20QFN (0	.5) (T7G)	20TQFN	20RQFN
	Outline Cliagram and Outline Dimensions	0				Bottom View)	(Bottom View)
	$L \times W \times H$ (mm)	$(4.0 \times 3.0 \times 0.9)$	$(3.8 \times 3.8 \times 0.9)$	(4 × 4 :		$.5 \times 3.5 \times 0.6$)	$(3.5 \times 2.5 \times 0.6)$
	Abbreviation	20LGA	24QFN	•		28QFN (K)	28QFN (T7A)
<r></r>	Outline Cliagram and Outline Dimensions L × W × H (mm)	(Bottom View) (3.0 × 3.0 × 0.6)	(5.0×4.0×1.0	(Bottor	m View)	0 1 × 4.7 × 1.0)	(5.0 × 5.0 × 0.7)
	Abbreviation	30SSOP		32QFN	36Q	FN	44QFN
	Outline Cliagram and Outline Dimensions L × W × H (mm)		(B	ottom View)	(6.0 × 6.0		6.0×6.0×1.0)
Į		(3.3 × 0.1 ×	1.0) (5.	$0 \times 5.0 \times 0.9$	(0.0 × 0.0	/ \ 1.0) (t	0.0 ^ 0.0 ^ 1.0)

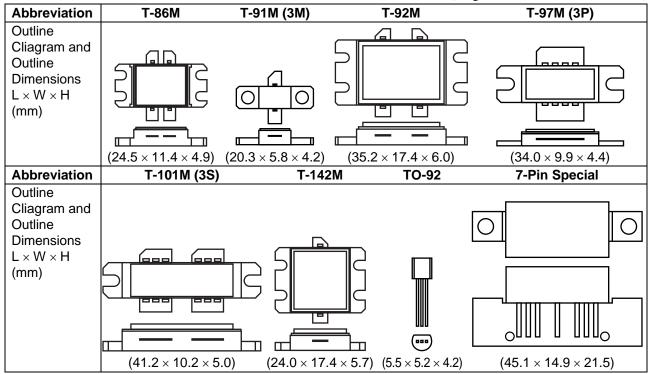
List of Special Type Package Drawings (1/2)

(Magnification of Dimensions \times 1.5)



List of Special Type Package Drawings (2/2)

(Magnification of Dimensions × 1.0)



Package List

Package group general index

Туре	Group	Abbreviation
Surface mount	3-pin	3MM, 3SMM, 3USMM, F3TUSMM, 3L2MM, 3TL2MM, 3SLM2, 3PMM
type	4-pin	4MM, 4SMM, F4TSMM, 4L2MM, 4PMM
	6-pin	6MM, 6SMM, 6TSMM, 6SLM2, 6L2MM, F6TUSMM, 6LGA, 6SON, 6TSON, 6TSSON
	8-pin	8SOP, 8SSOP, 8L2MM, 8TSON
	10-pin	10TSSOP, 10TSON, 10TSSON, 10LGA
	12-pin	12QFN, 12TQFN, 12TSQFN
	14-pin	14SOP, 14SSOP, 14LGA
	16-pin	16HTSSOP, 16QFN, 16SSOP, 16TSON
	20-pin	20SOP, 20SSOP, 20QFN, 20TQFN, 20RQFN, 20LGA
	24 to 36-pin	24QFN, 28QFN, 30SSOP, 32QFN, 36QFN
	44, 52-pin	44QFN, 52QFN
Special type	Low Noise	83A, 83B, 84, 84A, 84C, S01, S02, S03
	Power 1/2	75, 77, 79A, 95, 96/99
	Power 2/2	T-86M, T-91M (3M), T-92M, T-97M (3P), T-101M (3S), T-142M
	MCM, other	TO-92, 7-Pin Special, Chip

Surface mount type 3-pin package list

Abbreviation	3MM (33)	3SMM	3USMM	3USMM F3TUSMM			3USMM F3TUSMM 3	
Outline Cliagram								
and Outline				(Top View)	(Top View)			
Dimensions					(TOP VICW)			
$L \times W \times H (mm)$								
Magnification				(Bottom View)	(Bottom View)			
of Dimensions								
× 3.5	$(2.9 \times 1.5 \times 1.1)$	$(2.0 \times 1.3 \times 0.9)$	$(1.6 \times 0.8 \times 0.8)$	$(1.4 \times 0.8 \times 0.6)$	$(1.0\times0.7\times0.5)$			
Abbreviation	3TL2MM	3SLM2 (0804)	3PMM (34)					
Outline Cliagram								
and Outline	(Top View)	(Tara Milana)	(T	op View) (Bottom)	View)			
Dimensions		(Top View)						
$L \times W \times H (mm)$				020				
Magnification	(Bottom View)	(Bottom View)						
of Dimensions		*						
× 3.5	$(1.2 \times 1.0 \times 0.3)$	$(0.8 \times 0.4 \times 0.4)$		$(4.5 \times 2.5 \times 1.5)$				

Abbreviation	Package Code		Package Code		Package Name	Drav	vings
	NE IC			Package	Land		
					Pattern		
3MM	33		3-Pin Minimold (33 PKG)	0	0		
3SMM	30		3-Pin Super Minimold	0	0		
3USMM	19		3-Pin Ultra Super Minimold (1608 PKG)	0	0		
F3TUSMM	M03		Flat-Lead 3-Pin Thin-Type Ultra Super Minimold	0	0		
3L2MM	M13		3-Pin Lead-Less Minimold	0	0		
3TL2MM	M53	T6J	3-Pin Thin-Type Lead-Less Minimold	0	0		
3SLM2	M33		3-Pin Super Lead-Less Minimold (0804 PKG)	0	0		
3PMM	34		3-Pin Power Minimold (34 PKG)	0	0		

Surface mount type 4-pin package list

Abbreviation	4MM	4SMM	F4TSMM (2012)			
Outline Cliagram			(Tan Minus)			
and Outline			(Top View)			
Dimensions						
$L \times W \times H (mm)$						
Magnification of			(Bottom View)			
Dimensions × 3.5						
	V	V				
	$(2.9 \times 1.5 \times 1.1)$	$(2.0 \times 1.3 \times 0.9)$	(2.0 × 1.3 × 0.6)			
Abbreviation	4L2MM (1208)		4PMM			
Outline Cliagram						
and Outline	(Top View)	(Top Vie	w) (Bottom View)			
Dimensions						
$L \times W \times H (mm)$	*					
Magnification of	(Bottom View)					
Dimensions × 3.5						
	$(1.2\times0.8\times0.5)$	(4.5	5 × 2.5 × 1.5)			

Abbreviation	Package Code		Package Name	Draw	ings
	NE	IC	Pa		Land
					Pattern
4MM	39		4-Pin Minimold (39)	0	0
4SMM	18		4-Pin Super Minimold (18)	0	0
F4TSMM	M04		Flat-Lead 4-Pin Thin-Type Super Minimold	0	0
F4TSMM	M05		Flat-Lead 4-Pin Thin-Type Super Minimold (2012 PKG)	0	0
4L2MM	M14		4-Pin Lead-Less Minimold (1208 PKG)	0	0
4PMM	M02		4-Pin Power Minimold	0	0

Surface mount type 6-pin package list

Abbreviation	6MM	6SMM		6TSMM	6L	2MM (1511)	F6TUSMM	
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 5.0					(I	(Top View) Bottom View)	(Top View) (Bottom View)	
	$(2.9\times1.5\times1.1)$	$(2.0 \times 1.3 \times 0)$	0.9)	$(2.0\times1.3\times0.6)$	(1.5	$5 \times 1.1 \times 0.6$	$(1.5\times1.1\times0.6)$	
Abbreviation	6L2MM (1	,		6SLM2 (1007)		6	6LGA	
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 5.0	(Top Vie (Bottom V	iew)		(Top View) (Bottom View) (1.0 × 0.7 × 0.4)			(Bottom View) 1.5 × 0.6)	
Abbreviation	6SON	ı		6TSON		6RTSON	6TSSON	
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 5.0		Bottom View)		view) (Bottom View)		(Top View) Bottom View)	(Top View) (Bottom View)	
	(3.0×2.0)	× 0.8)	(1.	$5\times1.5\times0.4)$	(2.0	$0 \times 1.3 \times 0.4$	$(1.0\times1.0\times0.4)$	

Abbreviation	Packa	ge Code	Package Name	Drawi	ings
	NE	IC		Package	Land
					Pattern
6MM		Т	6-Pin Minimold	0	0
6MM		TA	6-Pin Minimold	0	0
6SMM	M01	T Note	6-Pin Super Minimold	0	0
6SMM		TB	6-Pin Super Minimold	0	0
6TSMM		TF Note	6-Pin Thin-Type Super Minimold	0	_
6SLM2		TS Note	6-Pin Super Lead-Less Minimold (1007 PKG)	0	0
6L2MM		TK	6-Pin Lead-Less Minimold (1511 PKG)	0	0
F6TUSMM		TC Note	Flat-Lead 6-Pin Thin-Type Ultra Super Minimold	0	0
6L2MM	M16	TD Note	6-Pin Lead-Less Minimold (1208 PKG)	0	0
6LGA		T5B	6-pin LGA (CSP Type)	0	_
6SON		T5G	6-Pin Plastic SON	0	_
6TSON		T5N	6-Pin Plastic TSON (T5N)	0	0
6TSON		T6N	6-Pin Plastic TSON (T6N)	0	0
6TSON		T6X	6-Pin Plastic TSON (T6X)	0	_
6RTSON		T7C	6-Pin Plastic RTSON (T7C)	0	-
6TSSON		T5K	6-Pin Plastic TSSON (T5K)	0	0
6TSSON		T6R	6-Pin Plastic TSSON (T6R)	0	0

Note: Twin Transistor

Surface mount type 8, 10-pin package list

Abbreviation	8SOP	8SSOP	8L2MM	8TSON
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 3.5			(Bottom View)	(Top View) (Bottom View)
	$(5.2 \times 4.4 \times 1.6)$	$(2.9 \times 3.2 \times 1.6)$	$(2.0\times2.0\times0.5)$	$(1.5\times1.5\times0.4)$
Abbreviation	10TSSOP	10TSON	10TSSON	10LGA
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 3.5	(2.8 × 2.2 × 1.1)	(Bottom View) (2.6 × 2.4 × 0.6)	(Top View) (Bottom View) (2.0 × 1.4 × 0.4)	(Top View) (Bottom View) (2.0 × 2.1 × 0.6)

Abbreviation	Package Code		Package Name	Drawings	
	NE	IC		Package	Land
					Pattern
8SOP		G, GR	8-Pin Plastic SOP (5.72 mm (225))	0	_
8SSOP		GV	8-Pin Plastic SSOP (4.45 mm (175))	0	0
8L2MM		TU	8-Pin Lead-Less Minimold	0	0
8TSON		T6Z	8-Pin Plastic TSON	0	0
10TSSOP		TH	10-Pin Plastic TSSOP	0	_
10TSON		TQ	10-Pin Plastic TSON	0	0
10TSSON		T6Q	10-Pin Plastic TSSON	0	0
10LGA		T5C	10-Pin LGA	_	-

Surface mount type 12, 14-pin package list

<r></r>	Abbreviation	12QFN	12QFN(T7K)	12TQFN	12TSQFN
	Outline Cliagram	(Top View)			
	and Outline Dimensions		(Top View)	(Top View)	
	L × W × H (mm)				(Top View)
	Magnification of				
	Dimensions	(Bottom View)			
	× 4.0	(Bottom View)	(Bottom View)	(Bottom View)	(Dottom View)
		The second second		J. P. C.	(Bottom View)
		Em			
		(0.0.00.00)	(0.0 0.0 0.0)	(0.5, 0.5, 0.4)	(0.0.00.04)
		$(3.0\times3.0\times0.8)$	$(2.0\times2.0\times0.6)$	$(2.5\times2.5\times0.4)$	$(2.0\times2.0\times0.4)$
	Abbreviation	148	OP	14SSOP	14LGA
	Outline Cliagram		A.		(Tan Minus)
	and Outline				(Top View)
	Dimensions L × W × H (mm)			L. L.	
	Magnification of			In the last of the	
	Dimensions				
	× 4.0				(Bottom View)
			◇		
		(40.0	4 4 0)	(5.4.4.4.6)	(0.5, 0.5, 0.6)
		(10.2 × 4	.4 × 1.6)	$(5.4 \times 4.4 \times 1.6)$	$(2.5\times2.5\times0.6)$

	Abbreviation	Packag	e Code	Package Name	Drawings	
		NE	IC		Package	Land
						Pattern
	12QFN		T5F	12-Pin Plastic QFN	0	0
<r></r>	12QFN		T7K	12-Pin Plastic QFN (T7K)	0	\circ
	12TQFN		T5J	12-Pin Plastic TQFN	0	0
	12TSQFN		T5L	12-Pin Plastic TSQFN (T5L)	0	0
	12TSQFN		T6M	12-Pin Plastic TSQFN (T6M)	0	0
	14SOP		G, GR	14-Pin Plastic SOP (5.72 mm (225))	0	_
	14SSOP		GR	14-Pin Plastic SSOP (5.72 mm (225))	0	0
	14LGA		T5D	14-Pin LGA (CSP Type)	0	0

Surface mount type 16-pin package list

Abbreviation	16HTSSOP	16QFN	16SSOP	16TSON
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 3.0	(Top View) (Bottom View)	(Top View) (Bottom View)		(Top View) (Bottom View)
	$(5.5 \times 5.2 \times 0.9)$	$(3.0\times3.0\times0.8)$	$(5.2 \times 4.4 \times 1.6)$	$(3.3\times2.3\times0.6)$

Abbreviation	Packag	je Code	Package Name	Draw	ings
	NE	IC		Package	Land
					Pattern
16HTSSOP	GR	GR	16-Pin Plastic HTSSOP	0	_
16QFN		T5T	16-Pin Plastic QFN (T5T)	0	0
16QFN		T6C	16-Pin Plastic QFN (T6C)	0	0
16QFN		T6S	16-Pin Plastic QFN (T6S)	0	0
16SSOP		GR	16-Pin Plastic SSOP (5.72 mm (225))	0	0
16TSON		T5A	16-Pin Plastic TSON	0	-

Surface mount type 20-pin package list

Abbreviation	20SOP		20880	P	20QFN (0.4)	20QFN (0.5) (K)	
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 3.0		C. W. C.	in the same	(Top View) (Bottom View)	(Top View) (Bottom View)		
	$(12.7 \times 5.6 \times 1.4)$.7)	(6.7×4.4)	× 1.6)	$(4.0 \times 3.0 \times 0.9)$	$(3.8 \times 3.8 \times 0.9)$	
Abbreviation	20QFN (0.5) (T7G)	20T	QFN	20RQFN		20LGA	
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 3.0	(Top View) (Bottom View)		o View)		(Top View) Bottom View)	(Top View) (Bottom View)	
	$(4.0\times4.0\times0.6)$	(3.5×3)	(3.5×0.6) $(3.5 \times 2.5 \times 0.6)$			$(3.0\times3.0\times0.6)$	

Abbreviation	Packag	ge Code	Package Name	Drawi	ings
	NE	IC		Package	Land
					Pattern
20SOP		GS	20-Pin Plastic SOP (7.62 mm (300))	0	-
20SSOP		GR	20-Pin Plastic SSOP (5.72 mm (225))	0	0
20QFN (0.4)		K	20-Pin Plastic QFN (0.4 mm pitch)	0	0
20QFN (0.5)		K	20-Pin Plastic QFN (0.5 mm pitch)	0	-
20QFN (0.5)		T7G	20-Pin Plastic QFN (0.5 mm pitch)	0	0
20TQFN		T6E	20-Pin Plastic TQFN	0	-
20RQFN		T5R	20-Pin Plastic RQFN	0	0
20LGA		T5E	20-Pin LGA	0	_

Surface mount type 24, 28, 30, 32, 36-pin package list

<r></r>	Abbreviation	24QFN	24QFN(T7L)	28QFN (K)	28QFN (T7A)
	Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 3.0	(Top View)	(Top View)	(Top View)	(Top View)
		(Bottom View)	(Bottom View)	(Bottom View)	(Bottom View)
		$(5.0\times4.0\times1.0)$		$(5.1 \times 4.7 \times 1.0)$	$(5.0\times5.0\times0.7)$
	Abbreviation	30\$	SOP	32QFN	36QFN
	Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 3.0			(Top View)	(Top View)
			ultitui	(Bottom View)	(Bottom View)
		(9.9 × 6.	.1 × 1.8)	$(5.0\times5.0\times0.9)$	$(6.0 \times 6.0 \times 1.0)$

	Abbreviation	Package Code		Package Name	Draw	ings
		NE	IC		Package	Land
						Pattern
	24QFN		K	24-Pin Plastic QFN	0	0
<r></r>	24QFN		T7L	24-Pin Plastic QFN (T7L)	0	0
	28QFN		K	28-Pin Plastic QFN (K)	0	0
	28QFN		T7A	28-Pin Plastic QFN (T7A)	0	0
	30SSOP		GS	30-Pin Plastic SSOP (7.62 mm (300))	0	_
	32QFN		T5S	32-Pin Plastic QFN	0	-
	36QFN		K	36-Pin Plastic QFN	0	_

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Surface mount type 44, 52-pin package list

Abbreviation	44QFN	52QFN
Outline Cliagram		(Top View)
and Outline		6
Dimensions	(Top View)	
$L \times W \times H \text{ (mm)}$	(TOP VIOW)	
Magnification of		
Dimensions × 3.0		
	0	
		(Bottom View)
	(Bottom View)	
	THE PERSON NAMED IN THE PE	
	E TILLI	E IIIIII
	E IIII	Fills
	$(6.0 \times 6.0 \times 1.0)$	$(7.0 \times 7.0 \times 1.0)$

Abbreviation	Package Code		Package Name	Drawings	
	NE	IC		Package	Land
					Pattern
44QFN		K	44-Pin Plastic QFN	0	_
52QFN		K	52-Pin Plastic QFN	_	_

Special type (Low Noise) 83A/83B, 84/84A/84C, S01, S02/S03 package list

Abbreviation	83A, 83B	84, 84A, 84C	S01	S02, S03
Outline Cliagram				
and Outline				
Dimensions				
$L \times W \times H \text{ (mm)}$				
Magnification of				
Dimensions × 4.0				
	(1.9 × 1.9 × 1.6)	(1.8 × 1.8 × 1.8)	(2.0 × 2.0 × 1.5)	(2.6 × 2.6 × 1.5)

Abbreviation	Package Code		viation Package Code Package Name	Drawings	
	NE IC			Package	Land
					Pattern
83A/83B	83A/83B		83A/83B Ceramic Package	0	-
84/84A/84C	84/84A/84C		84/84A/84C Ceramic Package	0	-
S01	S01		S01 Hollow Plastic Mold Package	0	0
S02/S03	S02/S03		S02/S03 Hollow Plastic Mold Package	0	_

Special type (Power 1/2) 75, 77, 79A, 95, 96/99 package list

Abbreviation	75		77	79A
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 2.0		6		
	$(9.8\times2.7\times2.3)$	(17.	$5 \times 6.4 \times 3.8$)	$(4.4 \times 4.2 \times 0.9)$
Abbreviation	95		9	6/99
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 2.0	6137	9		
	$(18.5 \times 5.9 \times 4)$.5)	(15.0 ×	4.3 × 5.0)

Abbreviation	Package Code		Package Name	Drawings	
	NE	IC		Package	Land
					Pattern
75	75		75 Ceramic Package	0	-
77	77		77 Ceramic Package	0	_
79A	79A		79A Plastic Mold Package	0	0
95	95		95 Ceramic Package	0	-
96/99	96/99		96/99 Ceramic Package	0	_

Special type (Power 2/2) T-86M, T-91M (3M), T-92M, T-97M (3P), T-101M (3S), T-142M package list

Abbreviation	T-86M	T-91M (3M)	T-92M
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 1.0			
	$(24.5 \times 11.4 \times 4.9)$	$(20.3\times5.8\times4.2)$	$(35.2 \times 17.4 \times 5.7)$
Abbreviation	T-97M (3P)	T-101M (3S)) T-142M
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 1.0			
	$(34.0 \times 9.9 \times 4.4)$	$(41.2\times10.2\times5$	$(24.0 \times 17.4 \times 5.7)$

Abbreviation	Package Code		Package Name	Draw	rings
	NE	IC		Package	Land
					Pattern
T-86M			T-86M Hollow Plastic Mold Package	0	_
T-91M	3M		T-91M Hollow Plastic Mold Package	0	_
T-92M			T-92M Hollow Plastic Mold Package	0	_
T-97M	3P		T-97M Hollow Plastic Mold Package	0	_
T-101M	3S		T-101M Hollow Plastic Mold Package	0	_
T-142M			T-142M Hollow Plastic Mold Package	0	_

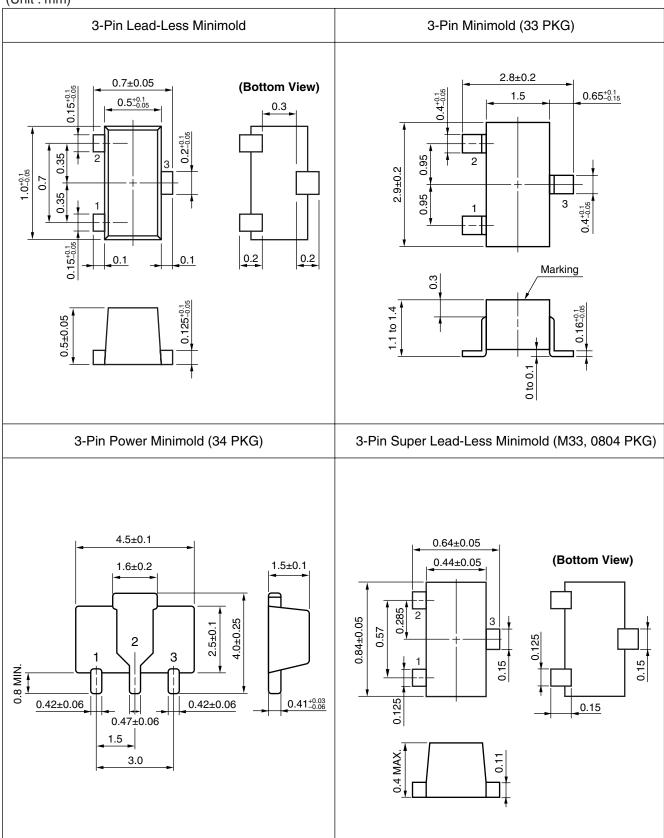
Special type (MCM, other) TO-92, 7-Pin Special, Chip package list

Abbreviation	TO-92	7-Pin Special	Chip
Outline Cliagram and Outline Dimensions L × W × H (mm) Magnification of Dimensions × 1.0	$(5.5 \times 5.2 \times 4.2)$	(45.1 × 14.9 × 21.5)	The Chip size drawing is carried to the data sheet.

Abbreviation	Package Code		Package Name	Drawings	
	NE	IC		Package	Land
					Pattern
TO-92	32		TO-92 Plastic Mold Package	0	-
7-Pin Special			7-Pin Special With Heatsink	0	-
Chip	00		Chip	_	-

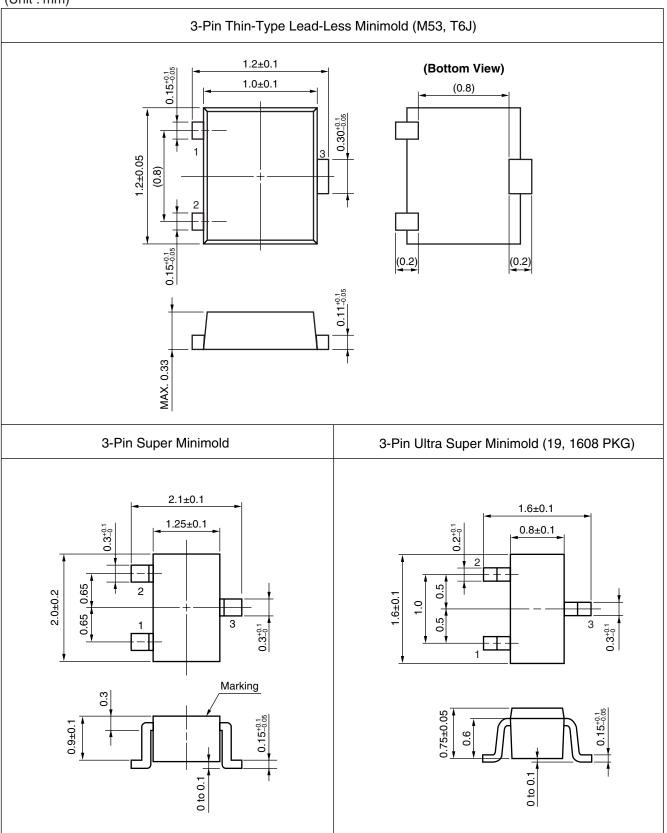
Package Dimensions (1/47)

(Unit: mm)

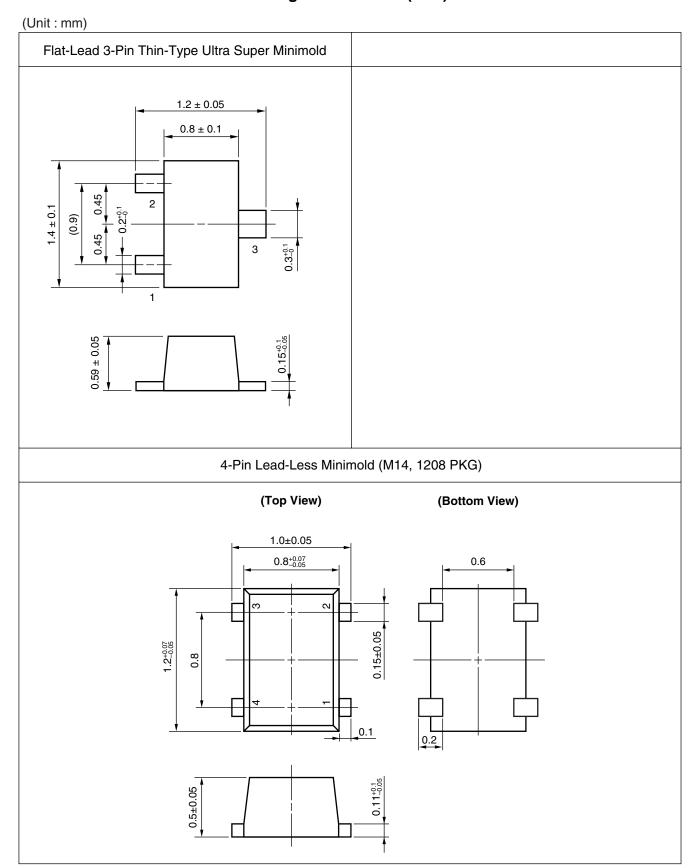


Package Dimensions (2/47)



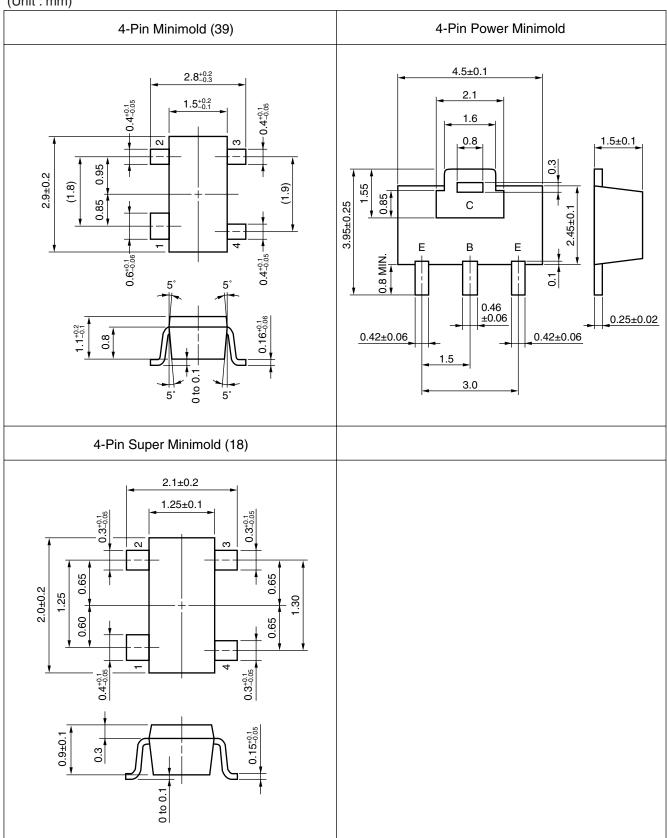


Package Dimensions (3/47)

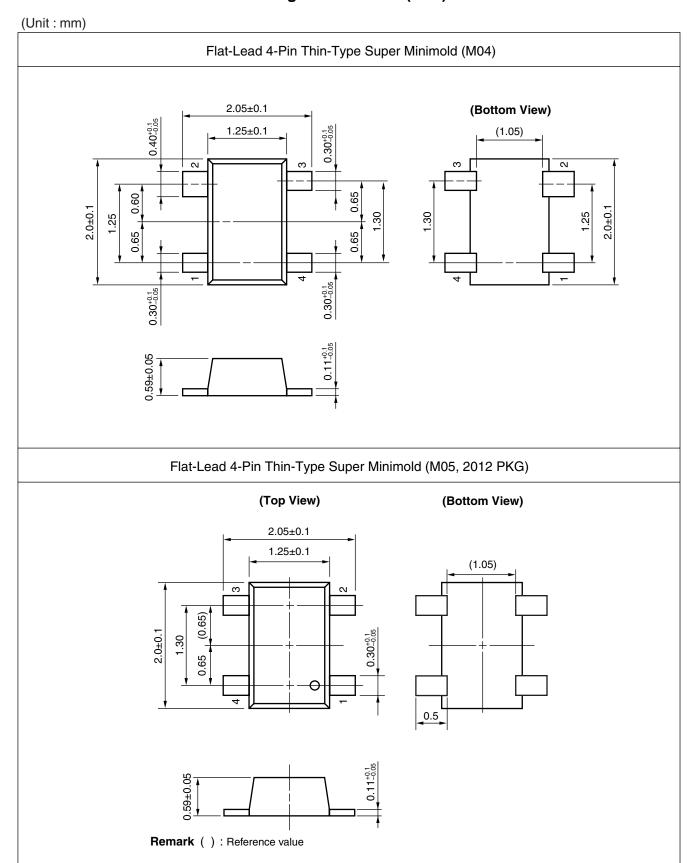


Package Dimensions (4/47)

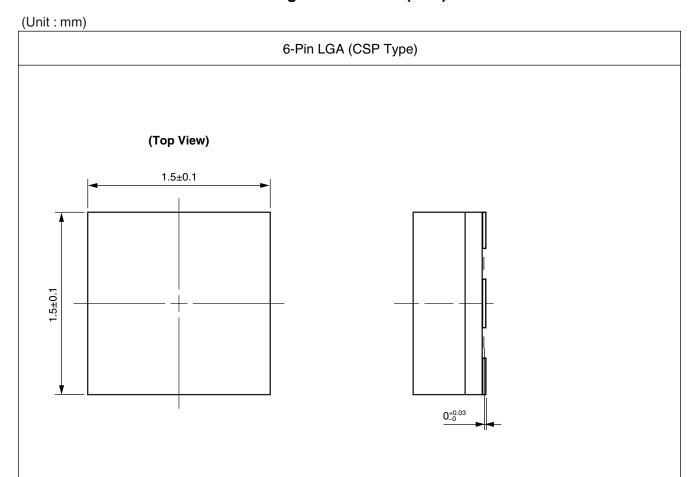
(Unit: mm)

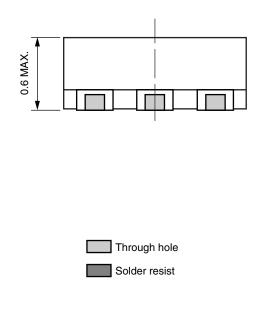


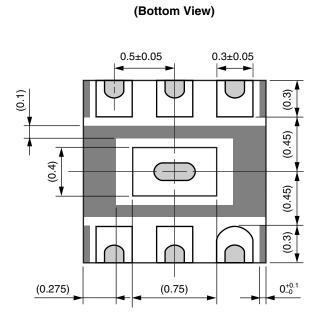
Package Dimensions (5/47)



Package Dimensions (6/47)

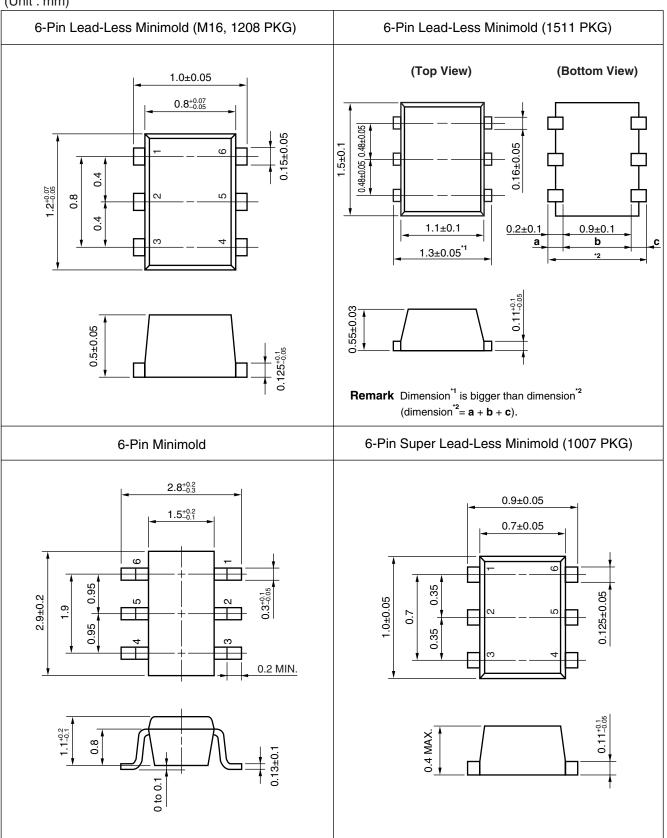






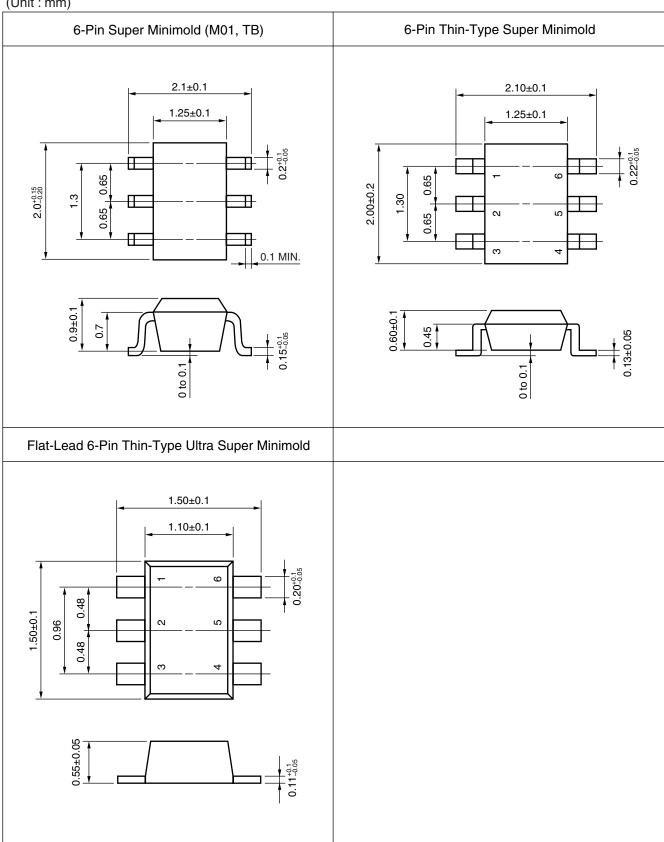
Package Dimensions (7/47)

(Unit: mm)



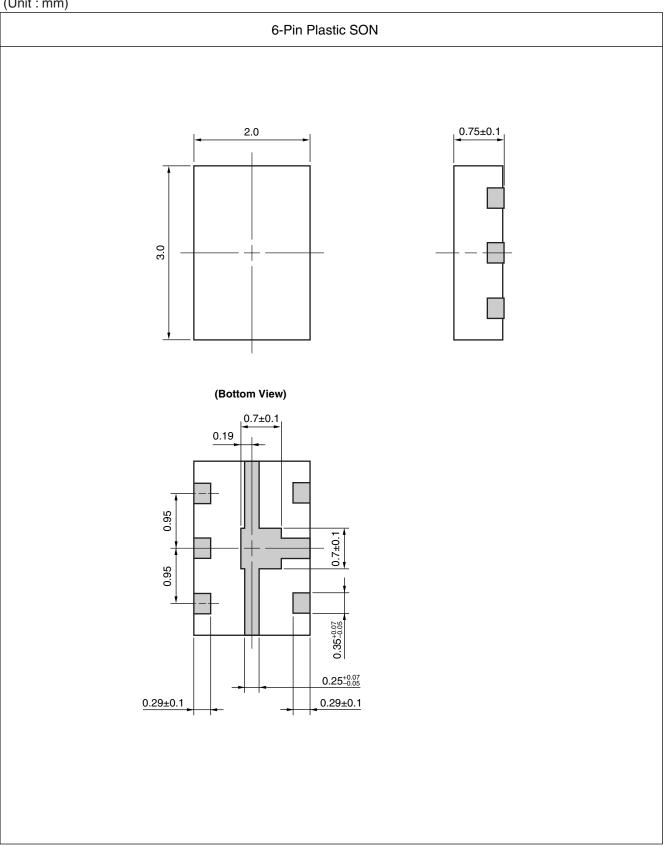
Package Dimensions (8/47)

(Unit: mm)

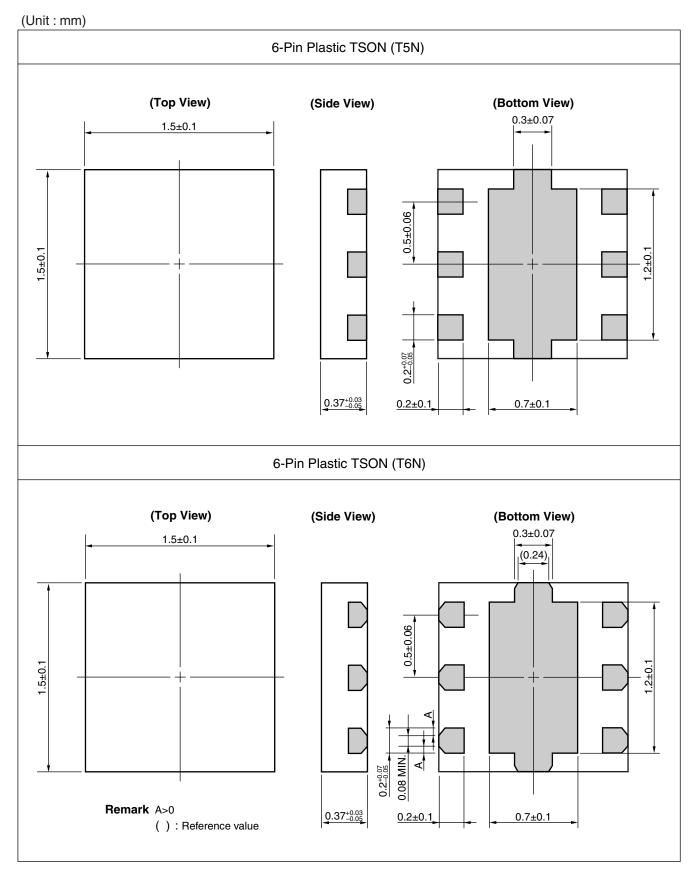


Package Dimensions (9/47)

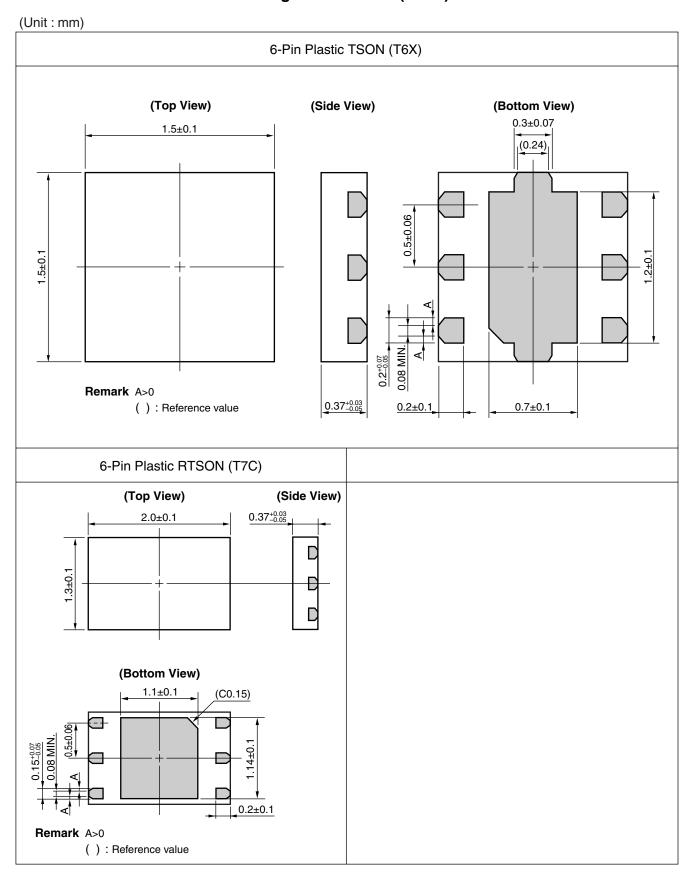




Package Dimensions (10/47)

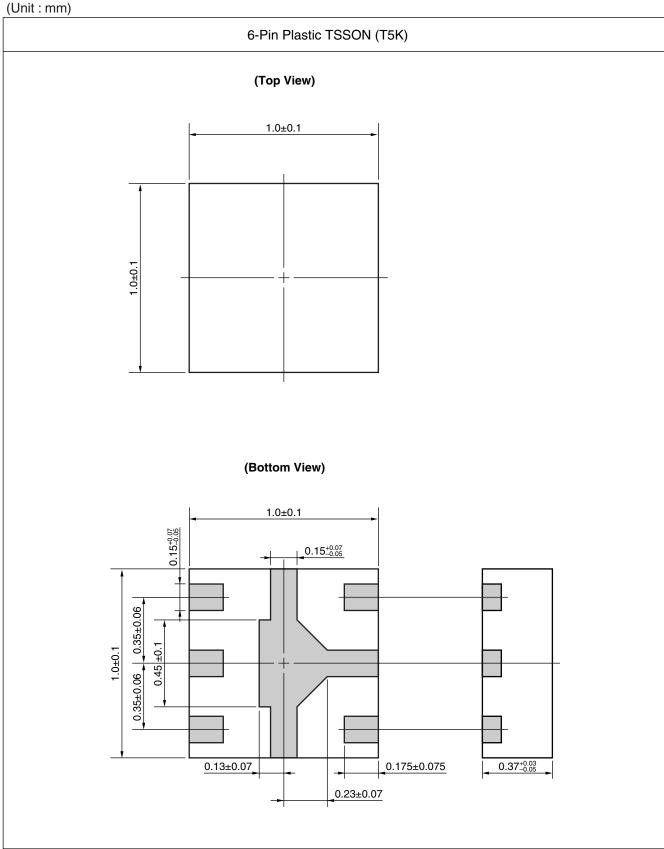


Package Dimensions (11/47)

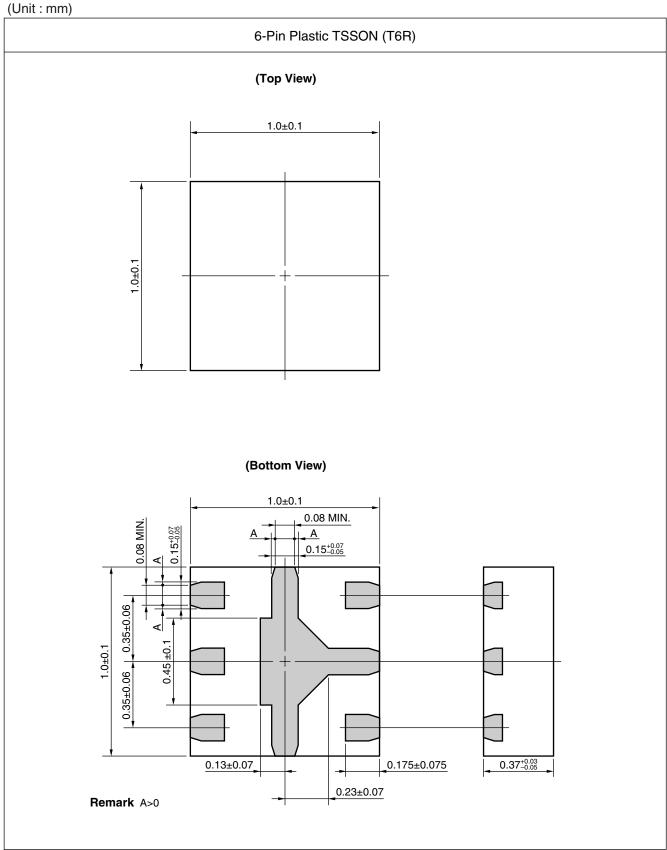


Package Dimensions (12/47)

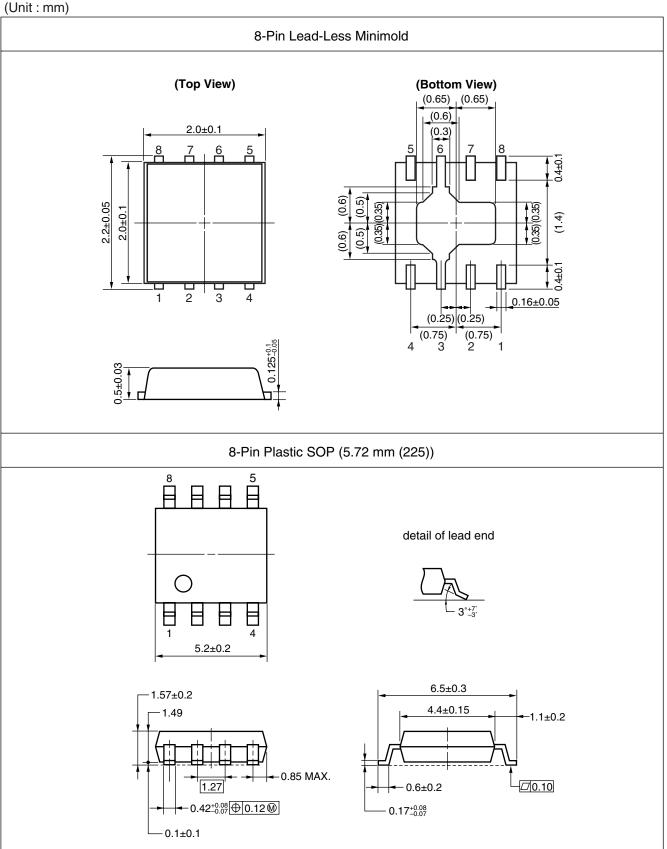




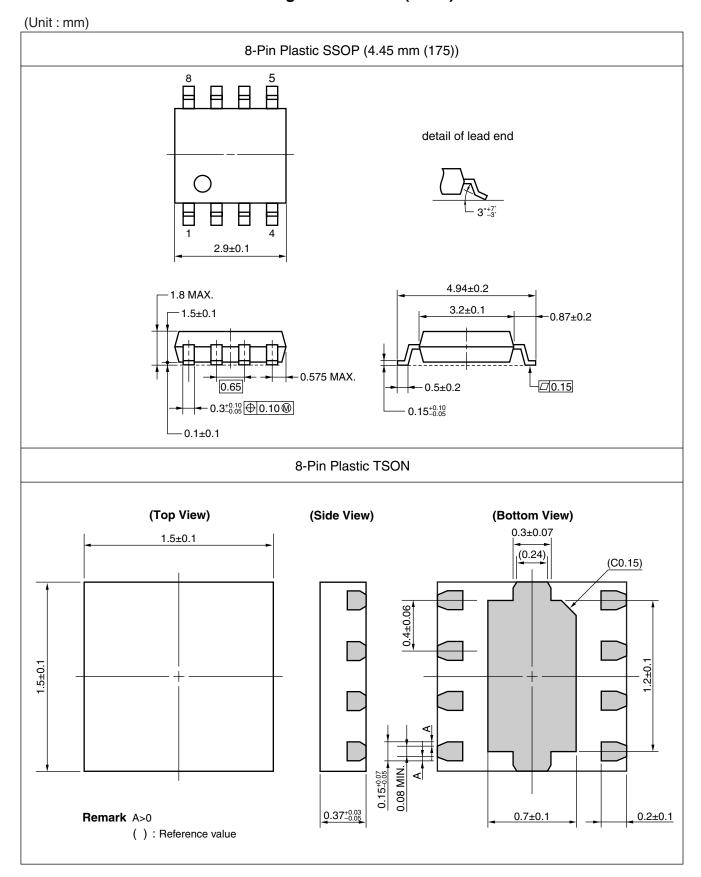
Package Dimensions (13/47)



Package Dimensions (14/47)

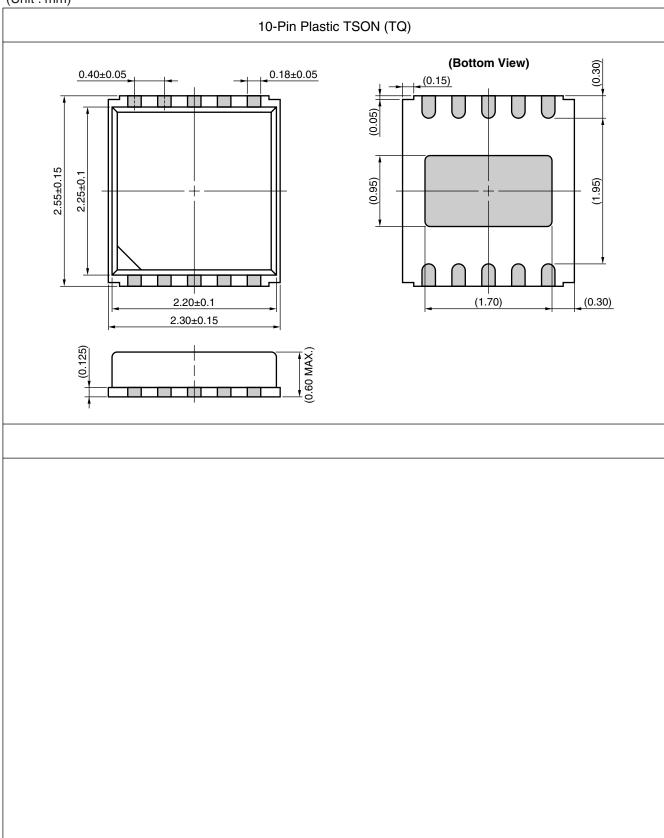


Package Dimensions (15/47)

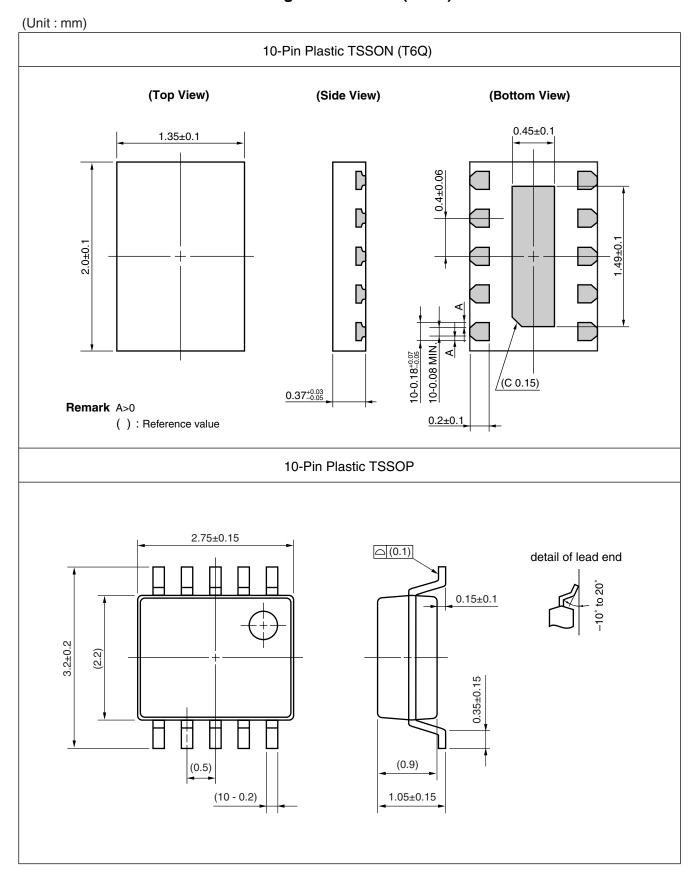


Package Dimensions (16/47)



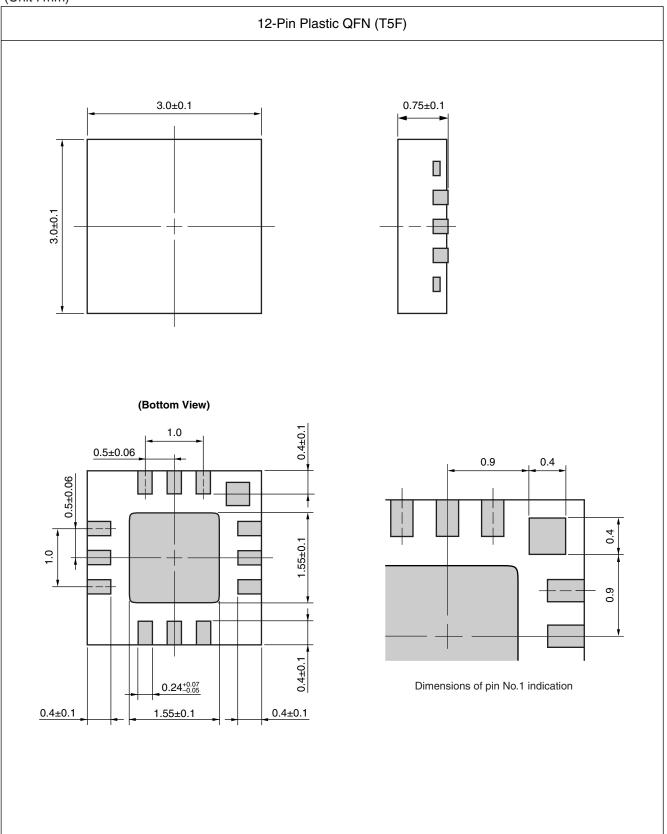


Package Dimensions (17/47)



Package Dimensions (18/47)





Package Dimensions (19/47)

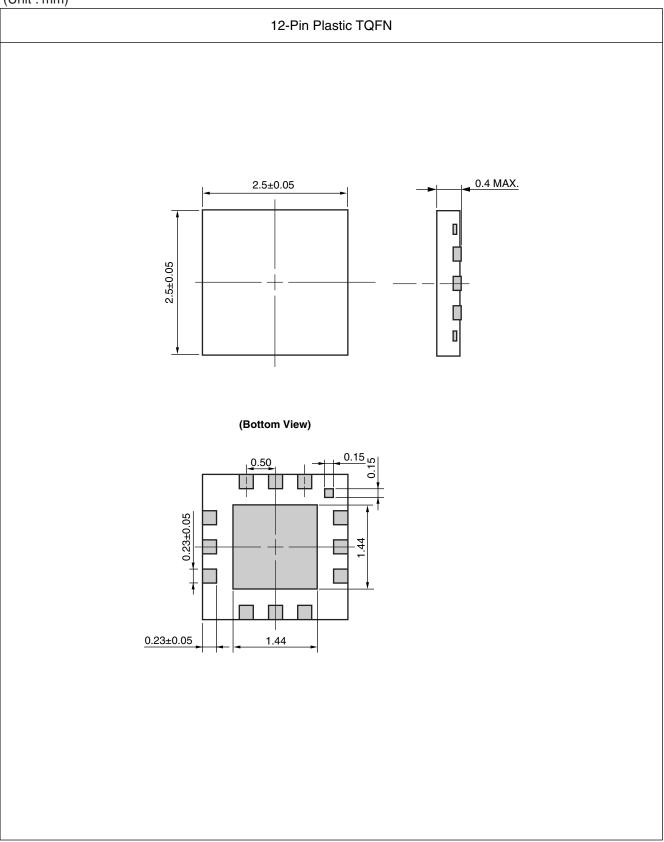
(Unit:mm)

<R>

12-Pin Plastic QFN (T7K) (Top View) (Side View) (Bottom View) 2±0.1 1.2±0.1 -(C0.2) 0.32 0.5±0.1 2±0.1 0.2±0.075 0.08 MIN. $0.57^{+0.03}_{-0.05}$ $0.2\substack{+0.07 \\ -0.05}$

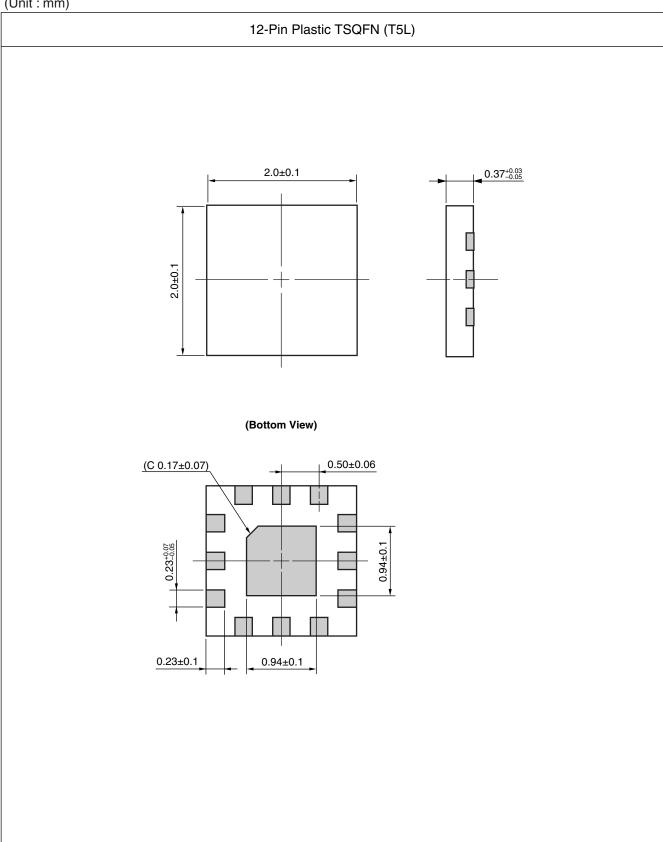
Package Dimensions (20/47)





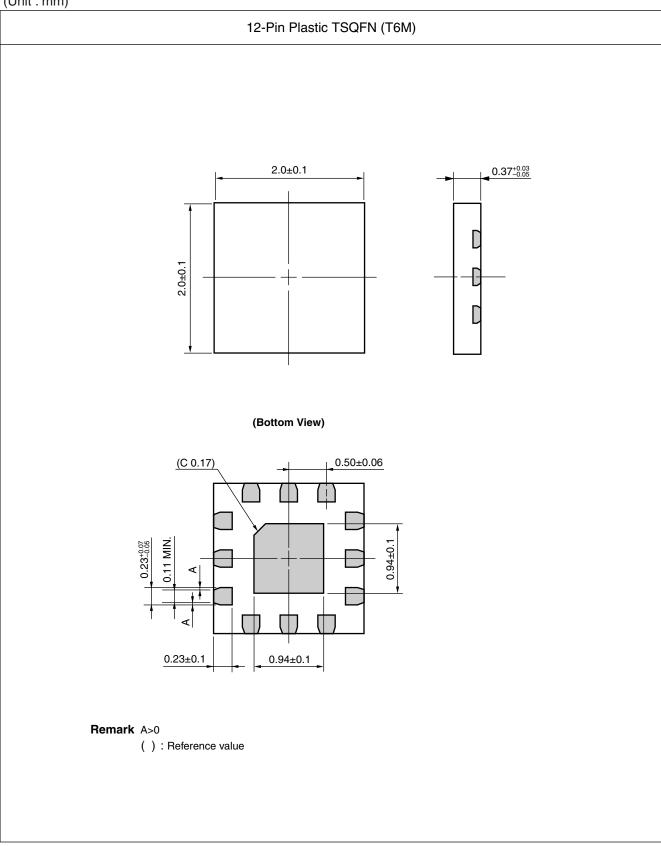
Package Dimensions (21/47)





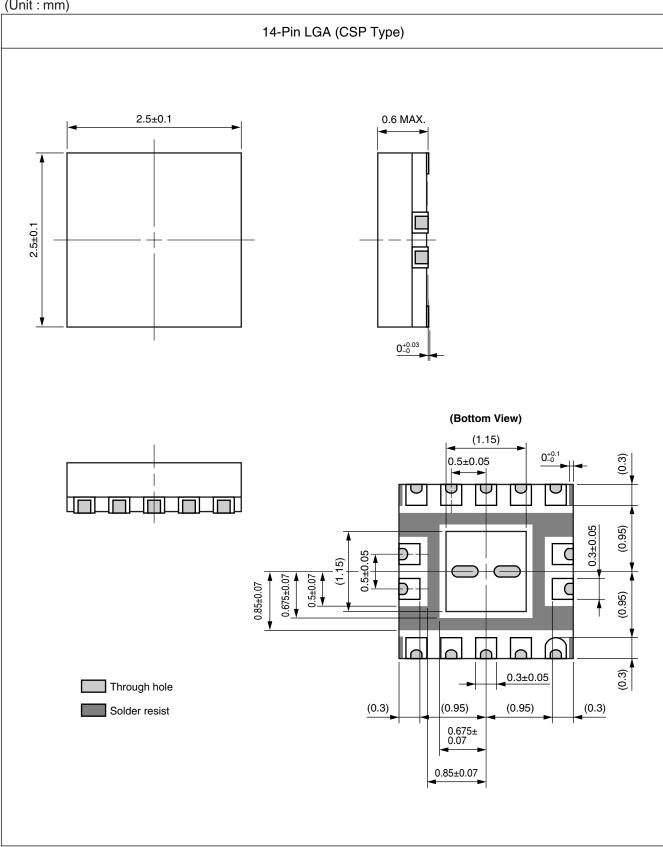
Package Dimensions (22/47)





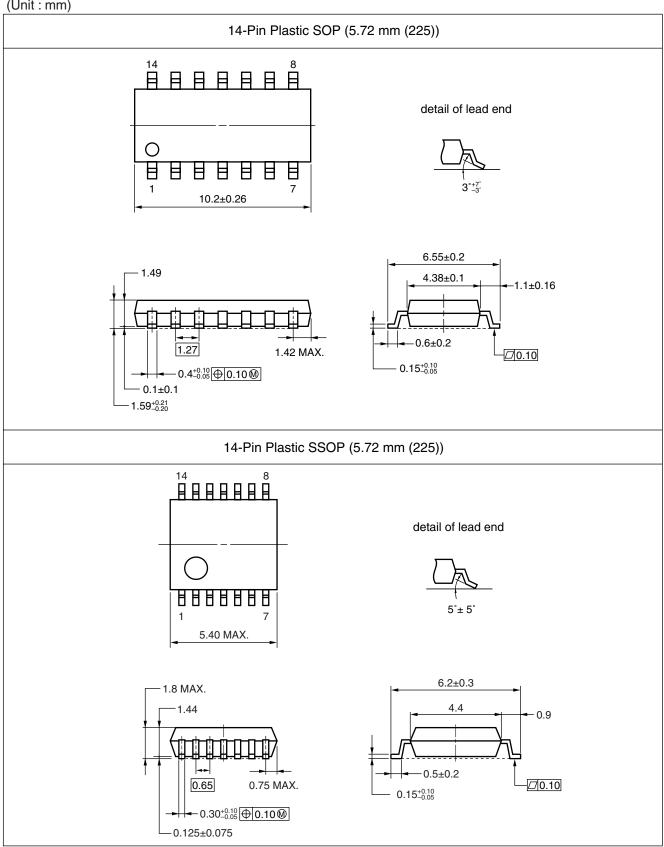
Package Dimensions (23/47)



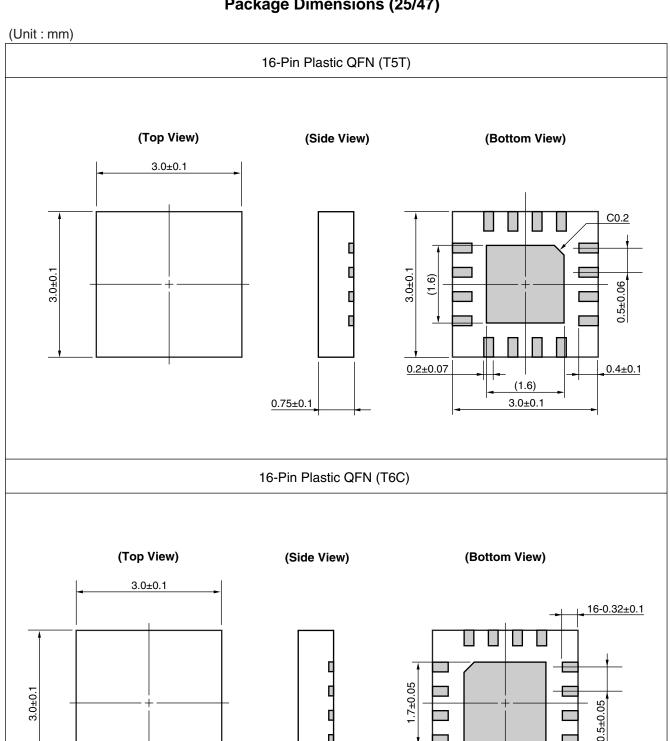


Package Dimensions (24/47)

(Unit: mm)



Package Dimensions (25/47)



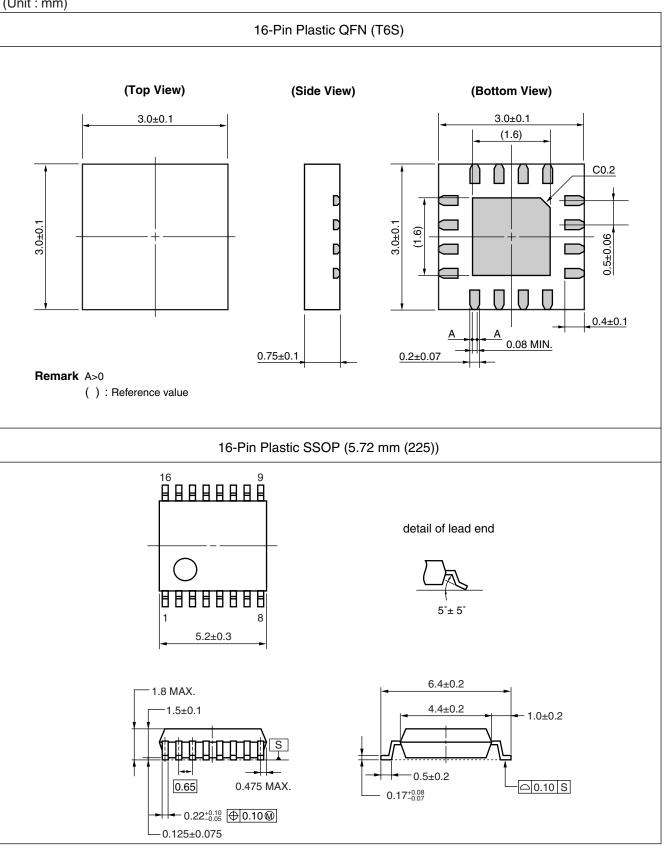
16-0.23±0.05

1.7±0.05

0.75±0.1

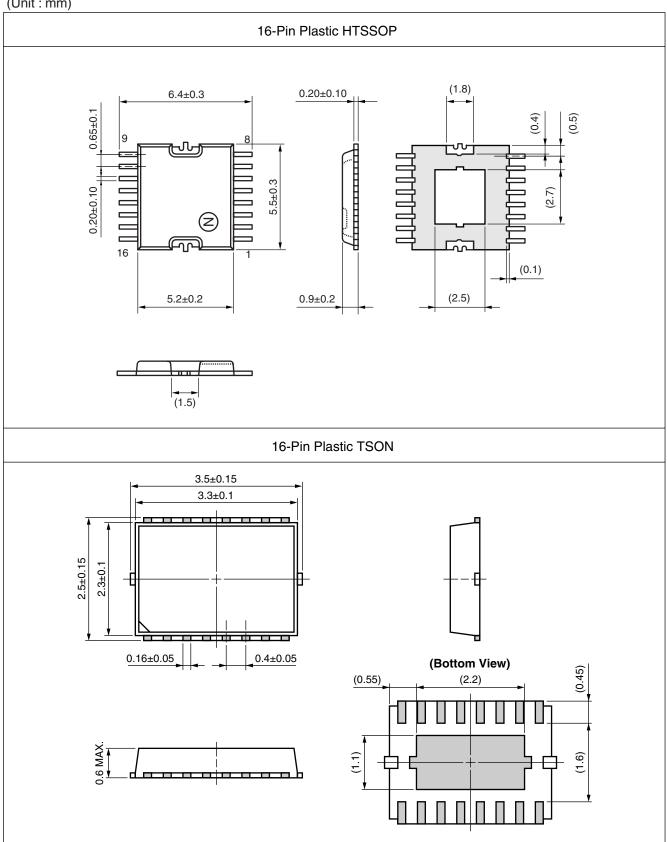
Package Dimensions (26/47)





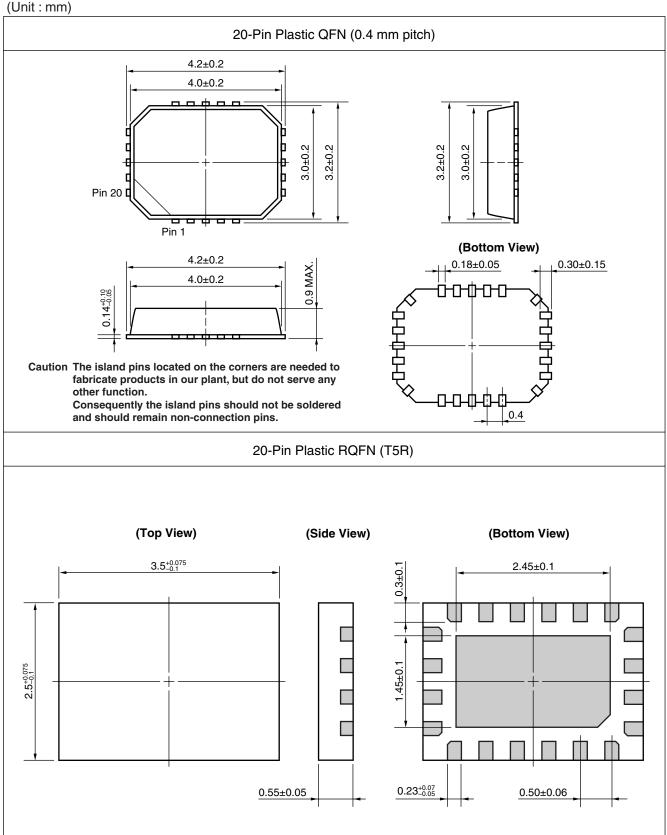
Package Dimensions (27/47)





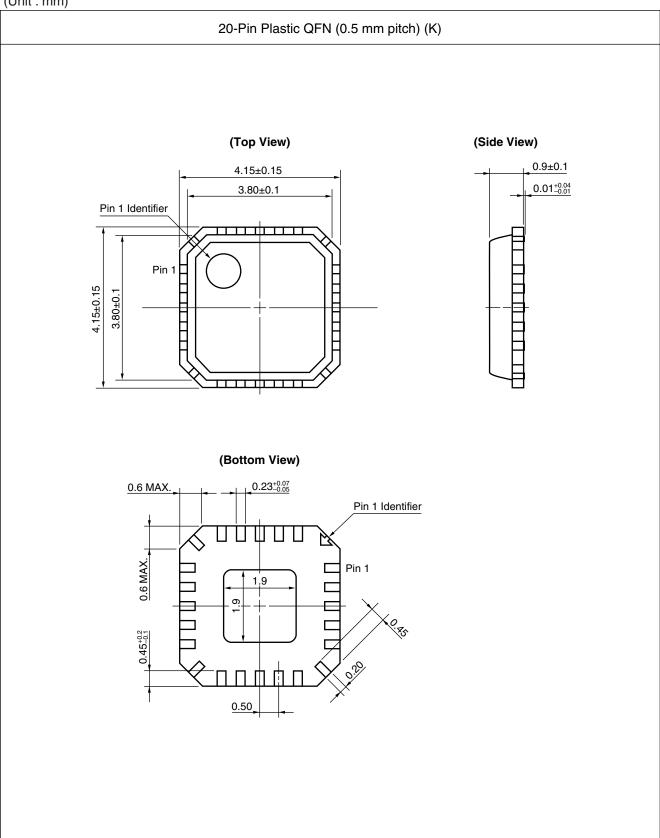
Package Dimensions (28/47)





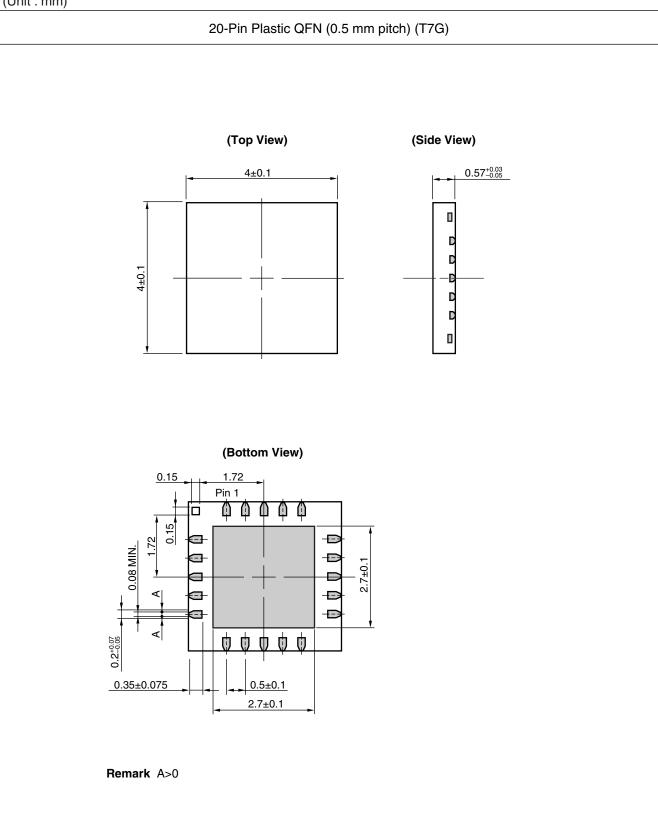
Package Dimensions (29/47)





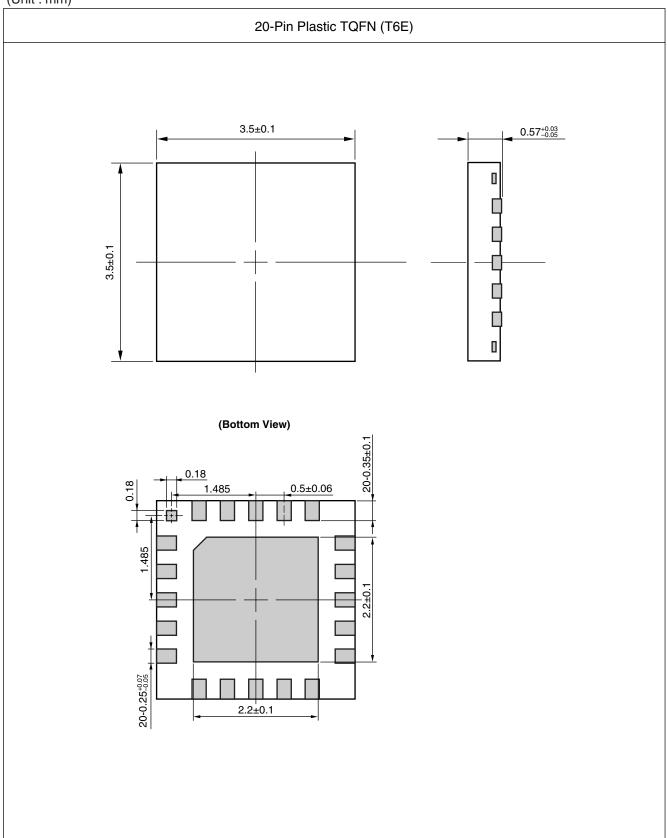
Package Dimensions (30/47)

(Unit: mm)

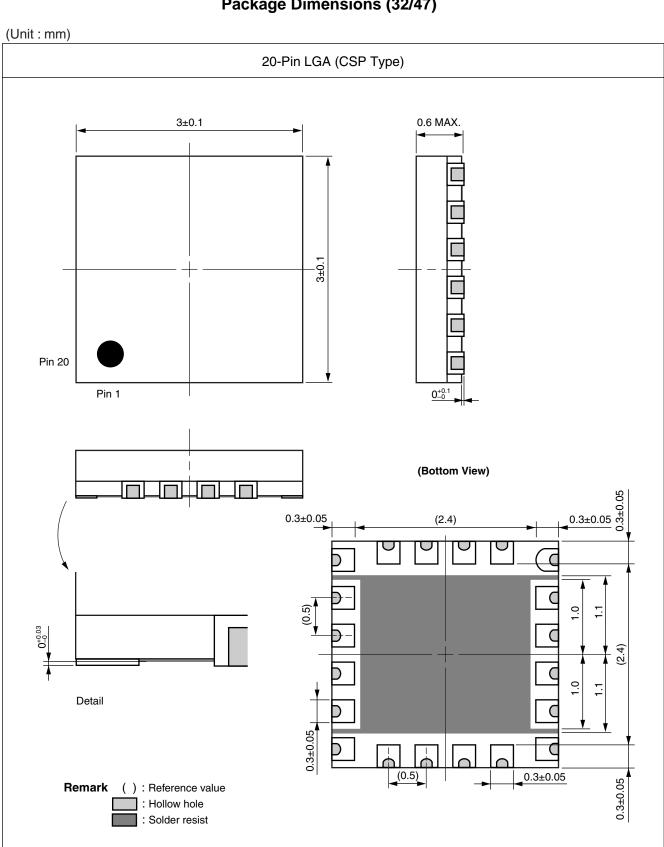


Package Dimensions (31/47)





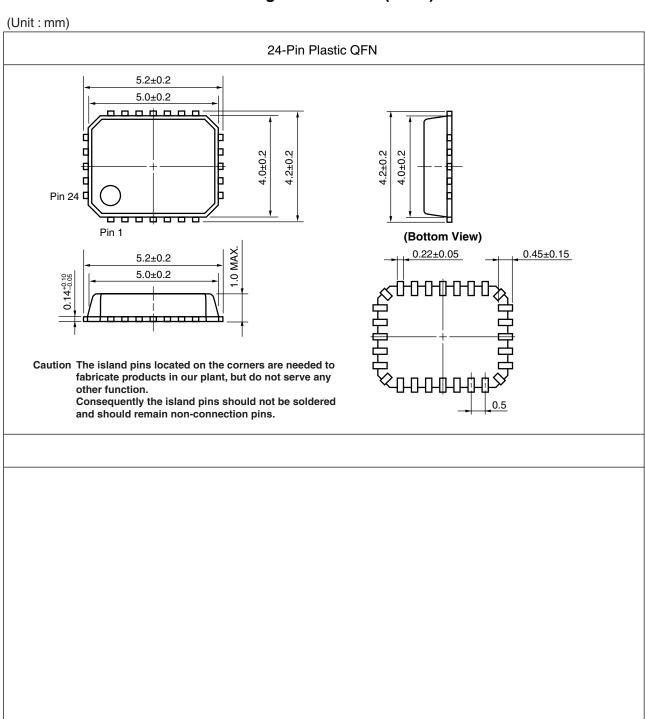
Package Dimensions (32/47)



Package Dimensions (33/47)

(Unit: mm) 20-Pin Plastic SOP (7.62 mm (300)) detail of lead end 0 12.7±0.3 7.7±0.3 - 1.55±0.1 5.6±0.2 -1.1 -0.78 MAX. 0.6 ± 0.2 1.27 ☑ 0.10 $0.20^{+0.10}_{-0.05}$ -0.4±0.1⊕0.12⑩ - 0.1±0.1 - 1.8 MAX. 20-Pin Plastic SSOP (5.72 mm (225)) detail of lead end 6.7±0.3 6.4±0.2 1.8 MAX. 4.4±0.1 -1.0±0.2 1.5±0.1 -0.5±0.2 - □ 0.15 $0.15^{+0.10}_{-0.05}$ -0.575 MAX. - 0.1±0.1

Package Dimensions (34/47)



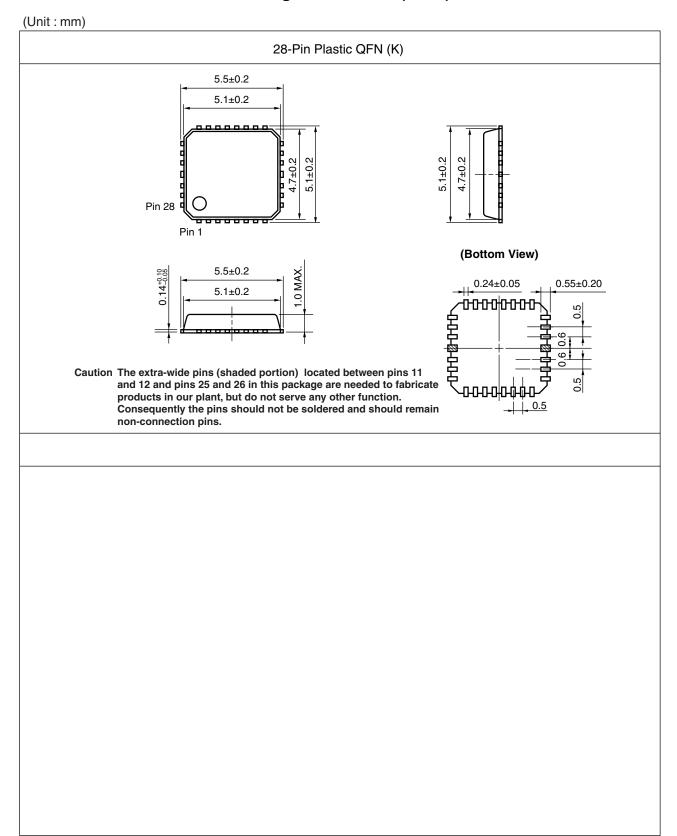
Package Dimensions (35/47)

(Unit: mm) 24-Pin Plastic QFN (T7L) <R> (Top View) (Side View) 4.0±0.1 $0.57^{+0.03}_{-0.05}$ 4.0±0.1 (Bottom View) Pin1 (Dimensions of Each Pin Part) (C0.2) $0.2^{+0.07}_{-0.05}$ Remark A > 0

0.35±0.075

 0.5 ± 0.1

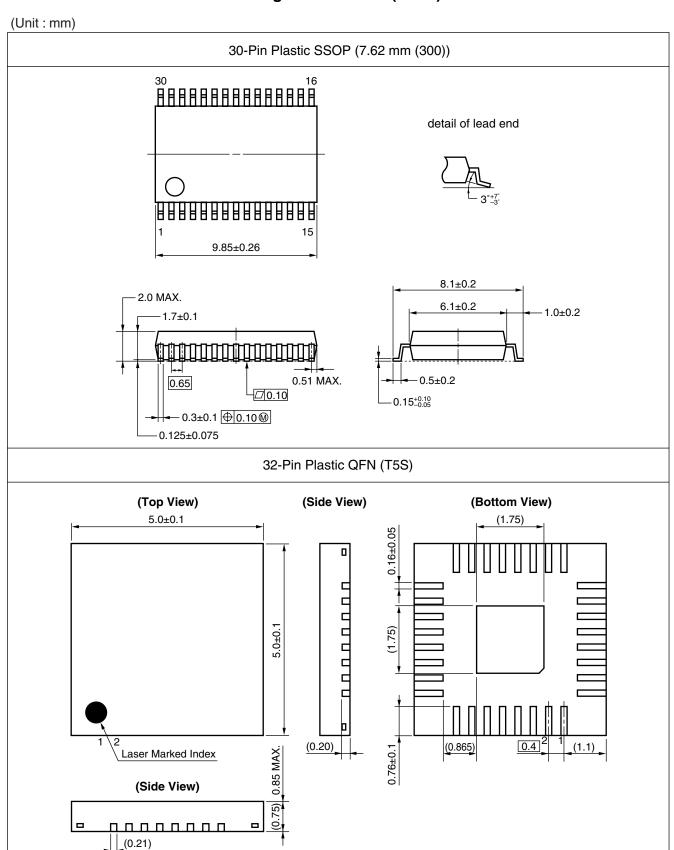
Package Dimensions (36/47)



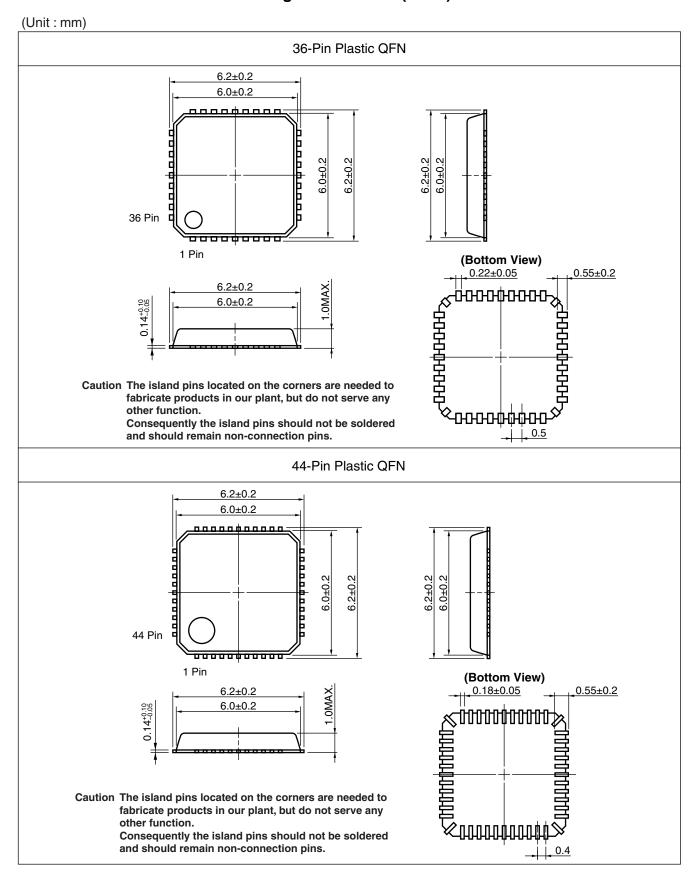
Package Dimensions (37/47)

(Unit: mm) 28-Pin Plastic QFN (T7A) (Top View) (Side View) 5.0±0.1 0.72±0.05 5.0±0.1 (Bottom View) (Dimensions of Each Pin Part) (C0.2) (0.325)0.4±0.05 0.08 MIN. 0.2±0.05 3.02±0.1 Remark A>0 (): Reference value

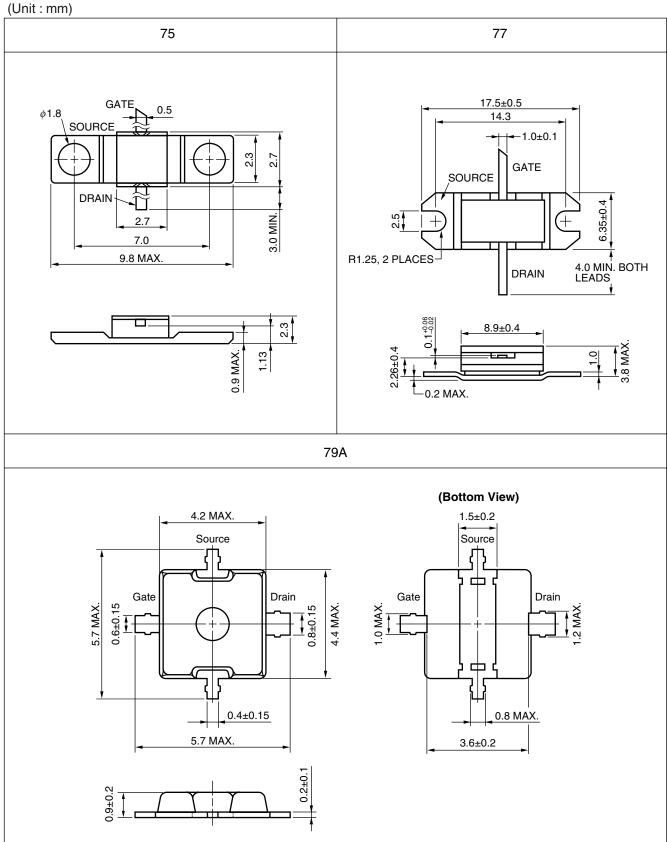
Package Dimensions (38/47)



Package Dimensions (39/47)

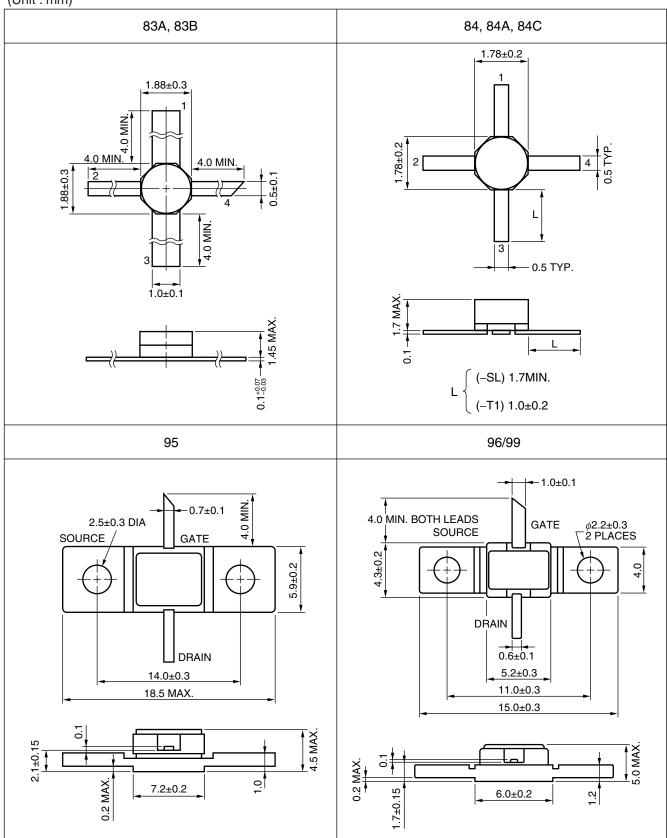


Package Dimensions (40/47)



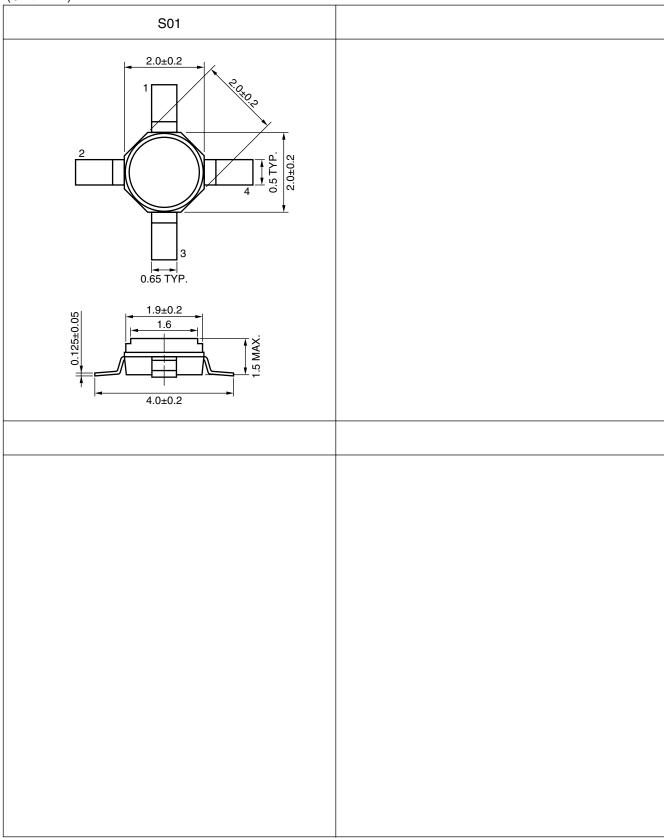
Package Dimensions (41/47)

(Unit: mm)



Package Dimensions (42/47)

(Unit:mm)

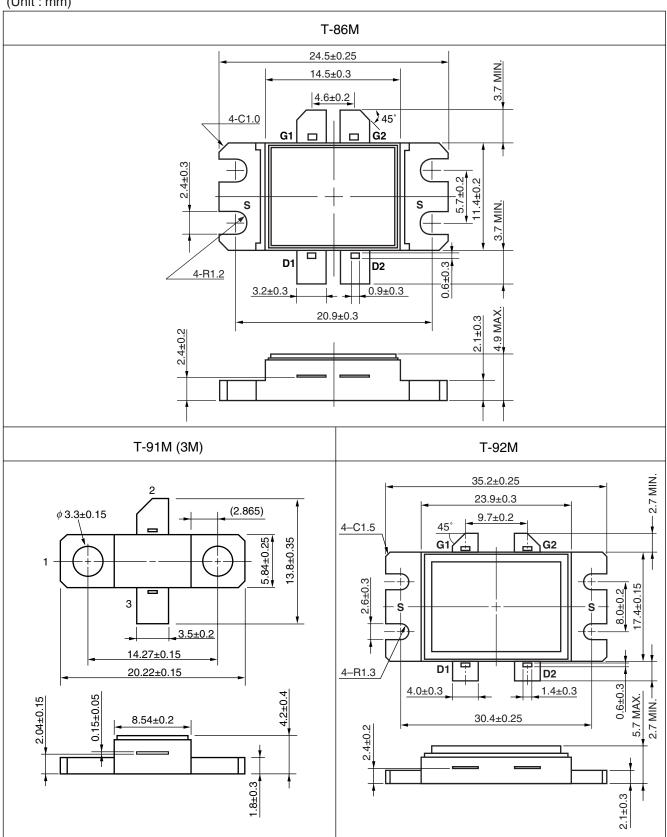


Package Dimensions (43/47)

(Unit: mm) S02, S03 (Top View) (Bottom View) 3.2 ± 0.2 0.65 TYP. 2.2±0.2 2.2±0.2 2.6±0.1 (Side View) 2.2±0.2 1.7 1.5 MAX. 3.2±0.2

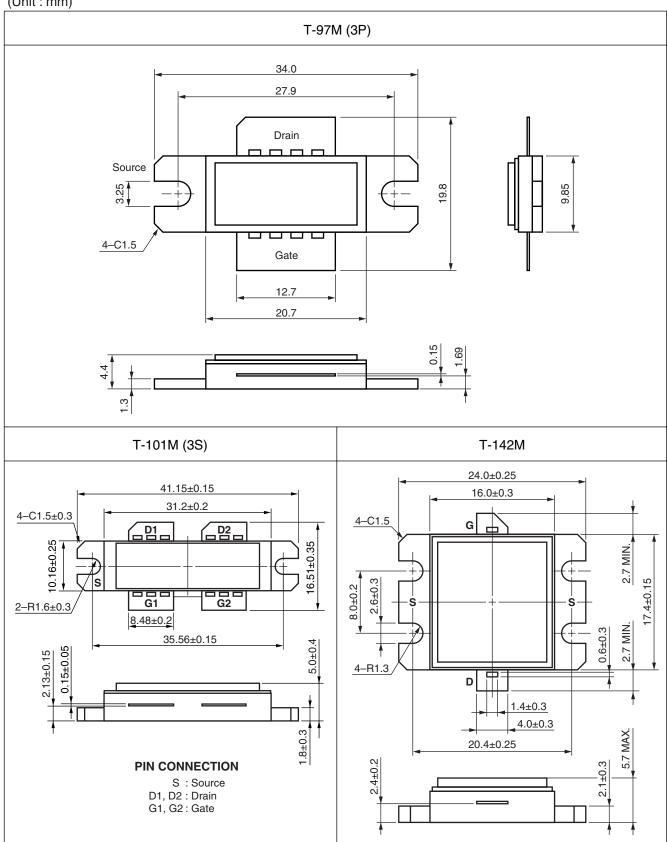
Package Dimensions (44/47)





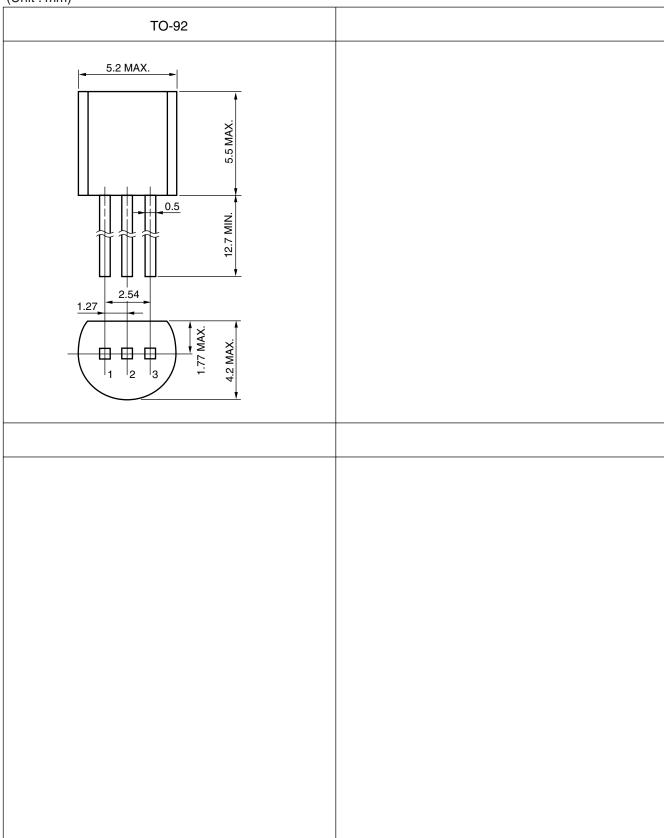
Package Dimensions (45/47)

(Unit: mm)



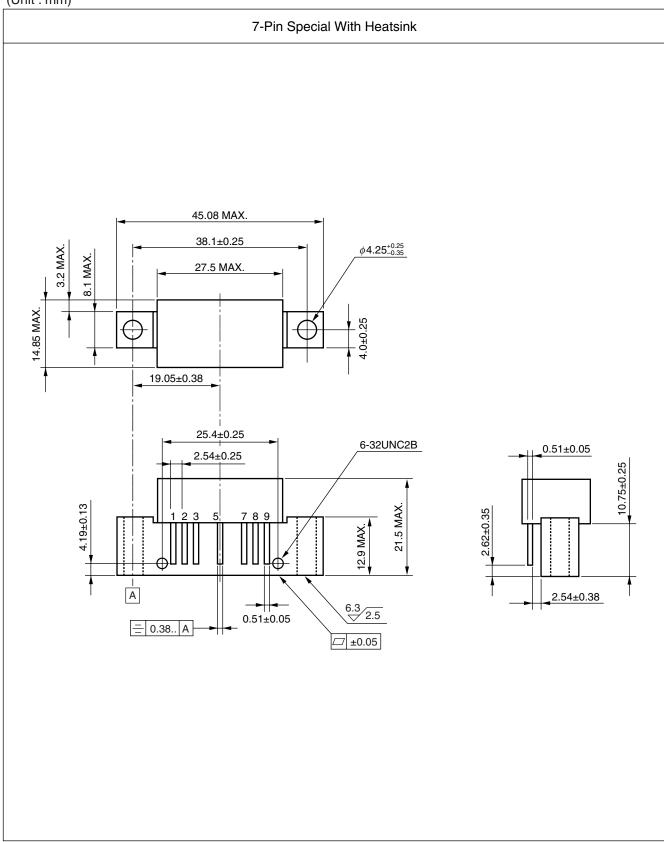
Package Dimensions (46/47)

(Unit:mm)



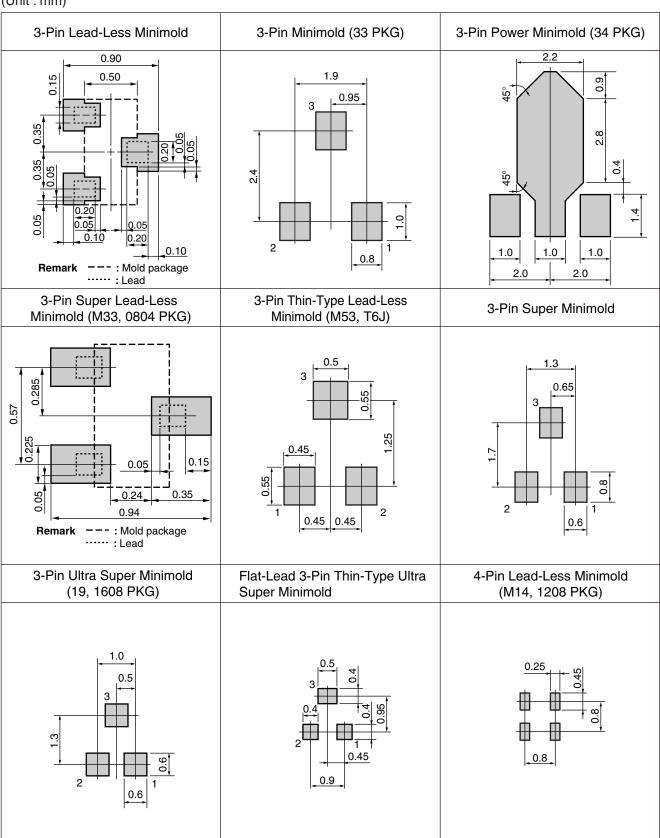
Package Dimensions (47/47)

(Unit: mm)



Mounting Pad Layout (1/6)

(Unit:mm)

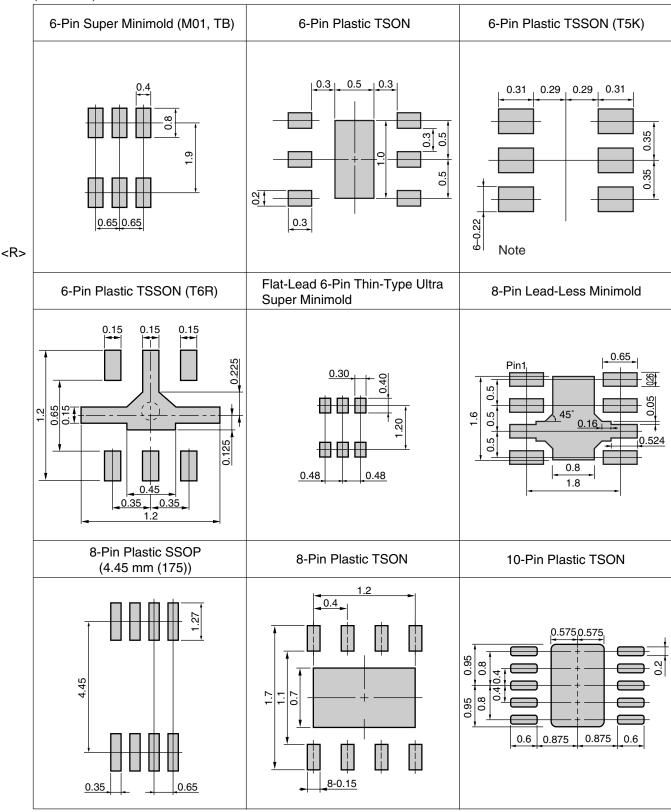


Mounting Pad Layout (2/6)

(Unit : mm)							
4-Pin Minimold (39)	4-Pin Power Minimold	4-Pin Super Minimold (18)					
3 1.0 4 0.1	2.7 1.5 1.5 1.0 1.0 1.0	3 0.6 4 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0					
Flat-Lead 4-Pin Thin-Type Super Minimold (M04)	Flat-Lead 4-Pin Thin-Type Super Minimold (M05, 2012 PKG)	6-Pin Lead-Less Minimold (M16, 1208 PKG)					
1.6	2 1.3 1 9 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	0.25					
6-Pin Lead-Less Minimold (1511 PKG) for Silicon MMIC/GaAs MMIC	6-Pin Minimold	6-Pin Super Lead-Less Minimold (1007 PKG)					
0.26	0.05 0.95	0.05 0.15 0.15 1.2 0.35 Remark: Mold package: Lead					

Mounting Pad Layout (3/6)

(Unit: mm)



<R> Note: This layout can also be adopted to some of the products in T6R package. Please refer to the data sheet of each product.

Mounting Pad Layout (4/6)

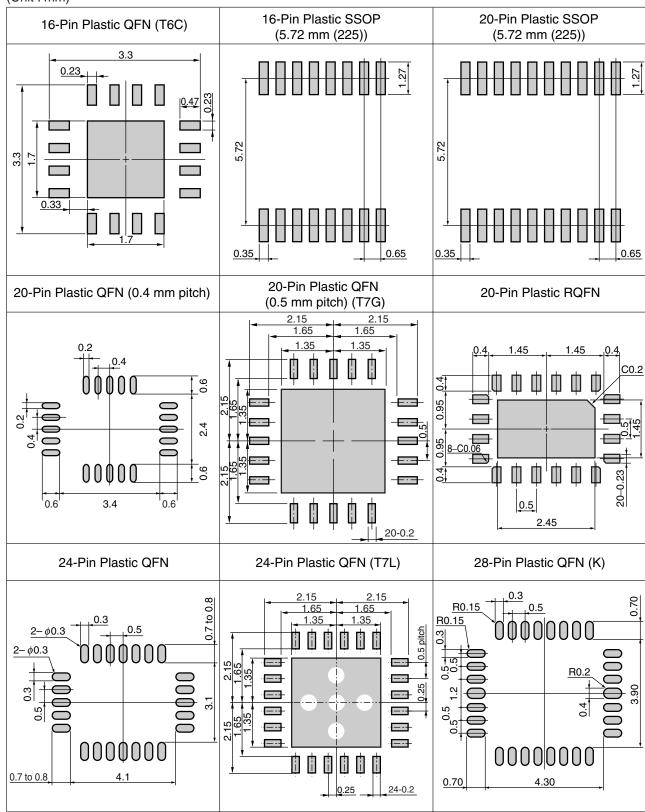
(Unit: mm)

10-Pin Plastic TSSON 12-Pin Plastic QFN 12-Pin Plastic QFN (T7K) <R> 0.45 0.65 1.0 1.0 1.15 0.5 0.5 0.8 0.8 10-0.18 0.5 0.5 C0.2 1.0 0. 0.65 12-0.3 12-0.15 0.475 0.475 1.55 0.825 12-Pin Plastic TQFN 12-Pin Plastic TSQFN (T5L) 12-Pin Plastic TSQFN (T6M) 0.97 0.97 0.33 0.77___0.77 0.72 0.5 0.5 0.94 0.94 0.33 0.94 0.94 12-0.25 0.5 14-Pin Plastic SSOP 14-pin LGA (CSP Type) 16-Pin Plastic QFN (T5T/T6S) (5.72 mm (225)) 1.15 0.5 9.0 0.3 0.5 0.8 0.8 0.6 1.6 0.35

Mounting Pad Layout (5/6)

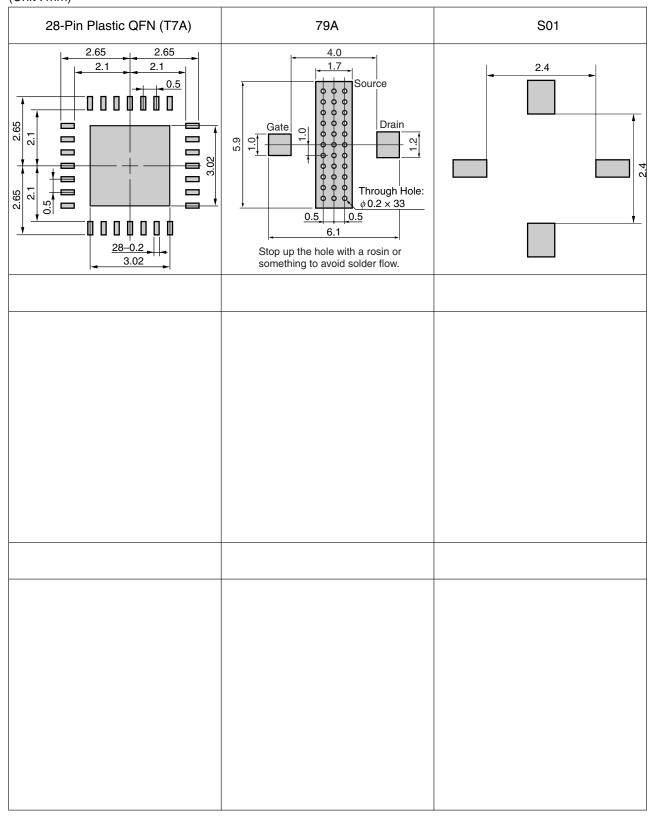
(Unit: mm)

<R>



Mounting Pad Layout (6/6)

(Unit:mm)



REVISION HISTORY

PACKAGES LINE-UP FOR RF AND MICROWAVE DEVICES Common Information

Rev.	Date	Description			
		Page	Summary		
1.00	Jul 22, 2010		Previous Number:PX10051EJ35V0TN		
		p.5	<surface actual="" illustrations="" line-up="" mount="" package="" size="" type=""> Addition of 20-Pin Plastic TQFN (T6E)</surface>		
		p.6	<list (1="" 2)="" drawings="" mount="" of="" package="" surface="" type=""> Addition of 6-Pin Plastic RTSON (T7C) Addition of 8-Pin Plastic TSON</list>		
		pp.9, 10,12, 13, 16	<package list=""> Addition of package code for 3-Pin Thin-Type Lead-Less Minimold (M53, T6J) Addition of 6-Pin Plastic RTSON (T7C) Addition of 8-Pin Plastic TSON Addition of 20-Pin Plastic TQFN</package>		
		pp.21, 30, 34	<package dimensions=""> Addition of package code for 3-Pin Thin-Type Lead-Less Minimold (M53, T6J) Addition of 6-Pin Plastic RTSON (T7C) Addition of 8-Pin Plastic TSON</package>		
		pp.62, 64	<mounting layout="" pad=""> Addition of package code for 3-Pin Thin-Type Lead-Less Minimold (M53, T6J) Addition of 8-Pin Plastic TSON</mounting>		
2.00	Oct 13, 2010	p.5	<surface actual="" illustrations="" line-up="" mount="" package="" size="" type=""> Addition of 6-Pin Plastic RTSON (T7C) Addition of 8-Pin Plastic TSON</surface>		
		p.7	<list (2="" 2)="" drawings="" mount="" of="" package="" surface="" type=""> Addition of 28-Pin Plastic QFN (T7A)</list>		
		pp.12, 13, 17	<package list=""> Addition of the illustration of 6-Pin Plastic RTSON (T7C) Addition of the illustration of 8-Pin Plastic TSON Addition of 28-Pin Plastic QFN (T7A)</package>		
		p.53	<package dimensions=""> Addition of 28-Pin Plastic QFN (T7A)</package>		
		p.68	<mounting layout="" pad=""> Addition of 28-Pin Plastic QFN (T7A)</mounting>		
3.00	Apr 27, 2011	p.6	<surface actual="" illustrations="" line-up="" mount="" package="" size="" type=""> Addition of 20-Pin Plastic QFN (0.5) (T7G) Addition of 28-Pin Plastic QFN (T7A)</surface>		
		p.8	<list (2="" 2)="" drawings="" mount="" of="" package="" surface="" type=""> Addition of 20-Pin Plastic QFN (0.5) (T7G)</list>		
		pp.17, 18	<package list=""> Addition of the illustration of 20-Pin Plastic QFN (0.5) (T7G) Addition of the illustration of 28-Pin Plastic QFN (T7A) Addition of 20-Pin Plastic QFN (0.5) (T7G)</package>		
		p.50	<package dimensions=""> Addition of 20-Pin Plastic QFN (0.5) (T7G)</package>		
		p.70	<mounting layout="" pad=""> Addition of 20-Pin Plastic QFN (0.5) (T7G)</mounting>		

Rev.	Date	Description			
		Page	Summary		
4.00	Dec 11, 2012	p.6	<surface actual="" illustrations="" line-up="" mount="" package="" size="" type=""> Addition of 12-Pin Plastic QFN (T7K) Addition of 24-Pin Plastic QFN (T7L)</surface>		
		p8	<list drawings="" mount="" of="" package="" surface="" type=""> Addition of 12-Pin Plastic QFN (T7K) Addition of 24-Pin Plastic QFN (T7L)</list>		
		p15	<surface 12,="" 14-pin="" list="" mount="" package="" type=""> Addition of 12-Pin Plastic QFN (T7K)</surface>		
		p18	< Surface mount type 24, 28, 30, 32, 36-pin package list> Addition of 24-Pin Plastic QFN (T7L)		
		pp.40, 56	<package list=""> Addition of 12-Pin Plastic QFN (T7K) Addition of 24-Pin Plastic QFN (T7L)</package>		
		P71	< Mounting Pad Layout > The note is added in Mounting Pad Layout of 6-Pin Plastic TSSON (T5K).		
		pp.72, 73	< Mounting Pad Layout > Addition of 12-Pin Plastic QFN (T7K) Addition of 24-Pin Plastic QFN (T7L)		

PACKAGES LINE-UP FOR RF AND MICROWAVE DEVICES **Common Information**

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PACKAGES LINE-UP FOR RF AND MICROWAVE DEVICES

